

## RZ/A2M Group

### Example of Initialization

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#### Introduction

This document describes required settings for initialization using the RZ/A2M boot mode 3 (Serial Flash booting , 3.3V product).

#### Target Device

RZ/A2M

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternative MCU.

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## 1. Specifications

After the reset is cancelled, the following devices are initialized by the program located in the serial flash memory assigned in SPI Multi I/O bus space.

SPI Multi I/O Bus Controller  
 Clock Pulse Generator  
 Interrupt Controller  
 OS Timer  
 General I/O Ports  
 Memory Management Unit  
 Primary Cache  
 Secondary Cache

Hereinafter, in this application note, SPI Multi I/O Bus Controller, Clock Pulse Generator, Interrupt Controller, OS Timer, Serial Communication Interface with FIFO, General I/O Ports, Power-down Mode and Memory Management Unit are referred to as SPIBSC, CPG, INTC, OSTM, SCIFA, STB and MMU, respectively.

Table 1.1 lists the peripheral functions supported in this application note. Also, Figure 1.1 shows the operation overview.

**Table 1.1 Peripheral Function to be Used**

Peripheral Function	Usage
SPI Multi I/O Bus Controller (SPIBSC)	Configure SPIBSC as external address space read mode and generate the signal for CPU to read data from serial flash memory assigned in SPI Multi I/O bus space directly
Clock Pulse Generator (CPG)	Generate the operating frequency of RZ/A2M
Interrupt Controller (INTC)	Control the interrupt fired by OSTM channel 0, OSTM channel 2 and SCIFA channel 4
OS Timer (OSTM)	Use OSTM channel 0 and channel2 <ul style="list-style-type: none"> <li>Channel 0 Control the cycle for blinking LED</li> <li>Channel 2 Use for time management by OS Abstraction Layer</li> </ul>
Serial Communication Interface with FIFO (SCIFA)	Control the communication between RZ/A2M and host PC using SCIFA channel 4
General I/O Ports (GPIO)	Switch the multiplexed pin functions for SCIFA channel 4 Control pins for blinking LED
Power-down Mode (STB)	Cancel the RZ/A2M peripheral I/O module standby Enable writing to the on-chip data retention RAM
Memory Management Unit (MMU), Primary (L1) Cache and Secondary (L2) Cache	Generate MMU translation table for configuring the area where L1 cache is enabled, memory attribute of each region of memory (i.e. Normal, Device, Strongly-Ordered), etc. Enable L1 and L2 Cache

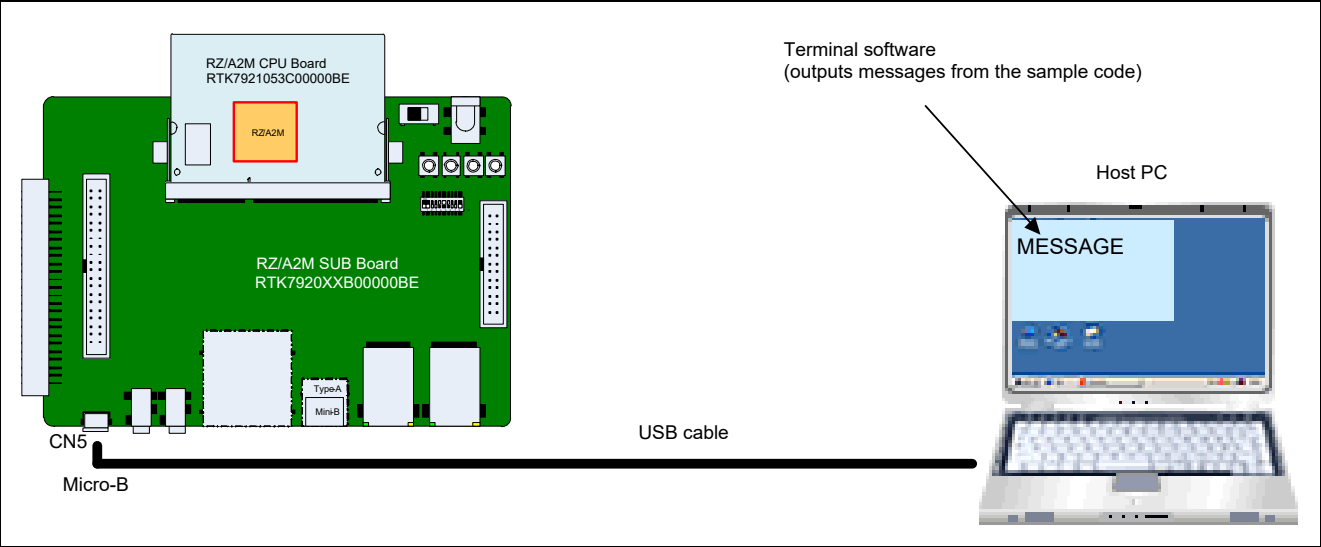


Figure 1.1 Operation Overview

## 2. Operation Confirmation Conditions

It was confirmed that the sample program accompanying this application note works as expected under the condition shown in Table 2.1 and Table 2.2.

**Table 2.1 Operation Conformation Condition (1/2)**

Item	Description
MCU used	RZ/A2M
Operating frequency (Note)	CPU Clock ( $I\phi$ ) : 528MHz Image processing clock ( $G\phi$ ) : 264MHz Internal Bus Clock ( $B\phi$ ) : 132MHz Peripheral Clock 1 ( $P1\phi$ ) : 66MHz Peripheral Clock 0 ( $P0\phi$ ) : 33MHz QSPI0_SPCLK : 66MHz CKIO : 132MHz
Operating voltage	Power supply voltage (I/O): 3.3 V Power supply voltage (either 1.8V or 3.3V I/O (PVcc SPI)) : 3.3V Power supply voltage (internal): 1.2 V
Integrated development environment	e2 studio V7.6.0
C compiler	"GNU Arm Embedded Tool chain 6-2017-q2-update" compiler options(except directory path)  Release Configuration: -mcpu=cortex-a9 -march=armv7-a -marm -mlittle-endian -mfloat-abi=hard -mfpu=neon -mno-unaligned-access -Os -ffunction-sections -fdata-sections -Wunused -Wuninitialized -Wall -Wextra -Wmissing-declarations -Wconversion -Wpointer-arith -Wpadded -Wshadow -Wlogical-op -Waggregate-return -Wfloat-equal -Wnull-dereference -Wmaybe-uninitialized -Wstack-usage=100 -fabi-version=0  Hardware Debug Configuration: -mcpu=cortex-a9 -march=armv7-a -marm -mlittle-endian -mfloat-abi=hard -mfpu=neon -mno-unaligned-access -Og -ffunction-sections -fdata-sections -Wunused -Wuninitialized -Wall -Wextra -Wmissing-declarations -Wconversion -Wpointer-arith -Wpadded -Wshadow -Wlogical-op -Waggregate-return -Wfloat-equal -Wnull-dereference -Wmaybe-uninitialized -g3 -Wstack-usage=100 -fabi-version=0

Note: The operating frequency used in clock mode 1 (Clock input of 24MHz from EXTAL pin)

**Table 2.2 Operation Conformation Condition (2/2)**

Item	Description
Operation mode	Boot mode 3 (Serial Flash booting , 3.3V product)
Terminal software communication settings	<ul style="list-style-type: none"> <li>• Communication speed: 115200bps</li> <li>• Data length: 8 bits</li> <li>• Parity: None</li> <li>• Stop bits: 1 bit</li> <li>• Flow control: None</li> </ul>
Board to be used	RZ/A2M CPU board RTK7921053C00000BE RZ/A2M SUB board RTK79210XXB00000BE
Device (functionality to be used on the board)	<ul style="list-style-type: none"> <li>• Serial flash memory allocated to SPI multi-I/O bus space <ul style="list-style-type: none"> <li>- Manufacturer : Macronix Inc.</li> <li>- Model Name : MX25L51245GXD</li> </ul> </li> <li>• RL78/G1C (USB-to-serial converter, which is used for communicating with host PC)</li> <li>• LED1</li> </ul>

### 3. Reference Application Notes

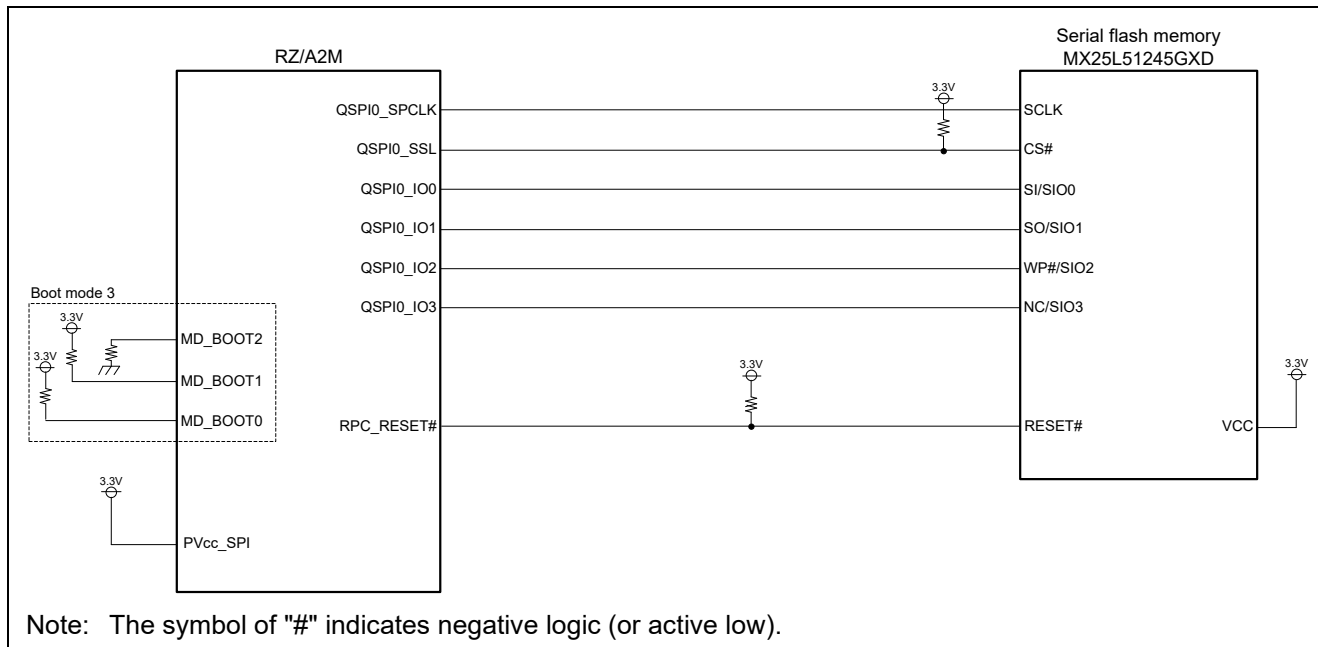
In this chapter, application note referenced in this note are listed:

- RZ/A2M Group Example of booting from serial flash memory (R01AN4333EJ)

## 4. Hardware

### 4.1 Hardware Configuration

In the example of initial setup described in this application note, boot mode is configured as boot mode 3 and so, all the processing runs by the program located in the serial flash memory connected to SPI Multi I/O bus space. Figure 4.1 shows the example of hardware connection diagram when RZ/A2M is booted up from serial flash memory assigned in SPI Multi I/O bus area under boot mode 3.



**Figure 4.1 Example of Connection Diagram under Boot Mode 3**



## 4.2 Pins Used

Table 4.1 lists the pins used in this application note.

**Table 4.1 Pins to be Used and Their Function**

Pin Name	I/O	Description
MD_BOOT2	Input	Boot mode selection (Select boot mode 3)
MD_BOOT1	Input	MD_BOOT2: "L", MD_BOOT1: "H", MD_BOOT0: "H"
MD_BOOT0	Input	
QSPI0_SPCLK	Output	Clock output to serial flash memory
QSPI0_SSL	Output	Slave selection for serial flash memory
QSPI0_IO0	Input/Output	Data 0 pin for serial flash memory
QSPI0_IO1	Input/Output	Data 1 pin for serial flash memory
QSPI0_IO2	Input/Output	Data 2 pin for serial flash memory
QSPI0_IO3	Input/Output	Data 3 pin for serial flash memory
RPC_RESET# (Note)	Output	Reset control signal output to serial flash memory
P6_0	Output	LED blinking
RxD4 (P9_1)	Input	Serial receive data signal
TxD4 (P9_0)	Output	Serial transmit data signal

Note: The symbol of "#" indicates negative logic (or active low)

## 5. Software

### 5.1 Operation Overview

After reset is canceled, the boot startup on-chip ROM program (hereinafter referred to as Boot Program) stored in on-chip ROM (address: H'FFFF 0000) for RZ/A2M runs. Boot Program, at first, sets up the configuration for accessing serial flash memory under boot mode 3 and then, jumps to the address H'2000 0000 which is the starting address of SPI Multi I/O bus space.

This initialization program consists of the loader program placed in the address H'2000 0000 and application program placed in the address H'2001 0000.

First, the loader program sets up the appropriate configuration for accessing serial flash memory and jumps to the start-up processing implemented in the application program.

Hereafter, it is described that how initialization is performed in the sample program.

In the start-up processing, the following initialization should be carried out and then jumps to resetprg function:

- Initialization of stack pointer
- MMU setup
- FPU setup
- Initialization of memory section

In resetprg function, after setting processing of unused channels of RTC and USB, the enablement of L1 and L2 cache and initialization of INTC are carried out. Then, a certain address of the area in large-capacity on-chip RAM is specified for VBAR in order to accelerate interrupt processing. Finally, IRQ and FIQ interrupt are enabled followed by main function call.

In the main function, initial setting processing of CPG, OSTM channel 0, SCIFA channel 4, GPIO is performed. As a result of these initialization processing being executed, the main function outputs the character strings (startup message) to the terminal on the host PC connected with the serial interface and sets OSTM channel 0 timer to interval timer mode to start the timer. OSTM channel 0 generates an interrupt of 500ms cycle, by using this OSTM interrupt, the sample code repeats turning on and off the LED on the CPU board every 500ms by interrupt processing.

For details on the processing implemented in loader program, please refer to the application note "Example of booting from serial flash memory".

Figure 5.1 shows the Sequence Diagram of Initialization until Main Processing Starts.

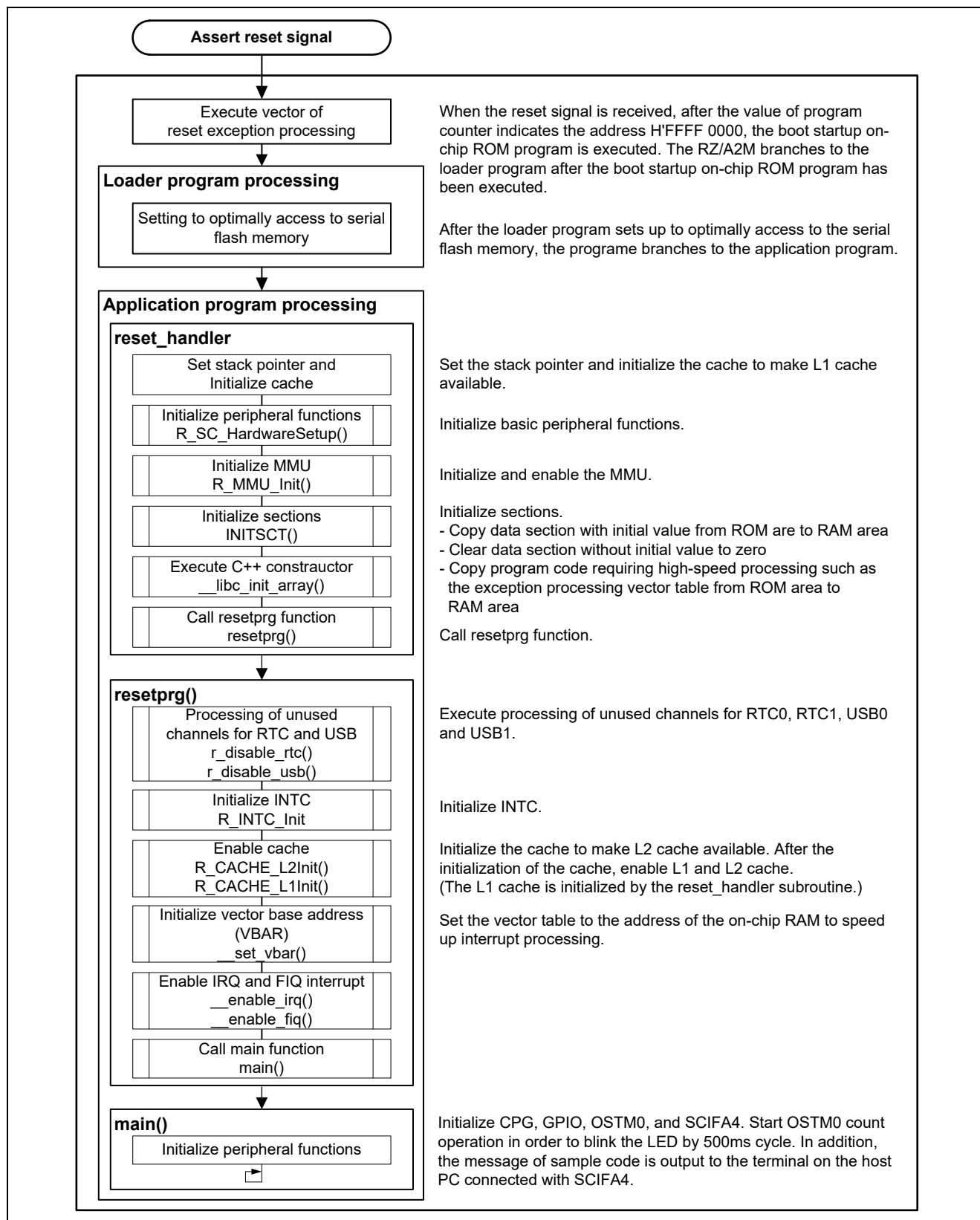


Figure 5.1 Sequence Diagram of Initialization until Main Processing Starts

## 5.2 Peripheral Functions and Memory Address Map in Sample Program

### 5.2.1 Setting for Peripheral Functions

Table 5.1 shows the Setting for Peripheral Functions in sample program.

**Table 5.1 Setting for Peripheral Functions**

Peripheral Functions	Setting
CPG	<p>CPU clock: 1/2 of the PLL circuit frequency            Internal bus clock: 1/8 of the PLL circuit frequency            Peripheral clock 1: 1/16 of the PLL circuit frequency</p> <p>Concretely, each clock becomes the following frequency under the Clock Mode 1 (i.e. Frequency division ratio by divider 1 is 1/2 and frequency of the input clock frequency is multiplied by 88) when the input clock frequency is 24MHz:</p> <ul style="list-style-type: none"> <li>• CPU clock (<math>I\phi</math>): 528MHz</li> <li>• Image processing clock (<math>G\phi</math>): 264MHz</li> <li>• Internal bus clock (<math>B\phi</math>): 132MHz</li> <li>• Peripheral clock 1 (<math>P1\phi</math>): 66MHz</li> <li>• Peripheral clock 0 (<math>P0\phi</math>): 33MHz</li> <li>• QSPI0_SPCLK: 66MHz (when selecting <math>B\phi</math> as output clock)</li> <li>• CKIO clock: 132MHz (when selecting <math>B\phi</math> as output clock)</li> </ul>
STB	Make on-chip Data Retention RAM writable and supply the clock to peripheral functions(OSTM0,OSTM2,and SCIF4).
GPIO	<p>Configure the multiplexed pin function of PORT6 and PORT9 as follows:</p> <ul style="list-style-type: none"> <li>• P6_0: LED blinking</li> <li>• P9_1: RxD4, P9_0: TxD4</li> </ul>
OSTM	<p>Configure the channel 0 and the channel 2 as interval timer mode:</p> <ul style="list-style-type: none"> <li>• Channel 0 Sets the timer counter to have interrupt request generated every 500ms when <math>P1\phi</math> is 66MHz. Control the cycle for blinking LED.</li> <li>• Channel 2 Sets the timer counter to have interrupt request generated every 1ms when <math>P1\phi</math> is 66MHz. Use for time management by OS Abstraction Layer.</li> </ul>
INTC	<p>Initial setup of INTC, interrupt handler registration and invocation            Used interrupt factor:</p> <ul style="list-style-type: none"> <li>• OSTM channel 0 interrupt handler (Interrupt ID: 88)</li> <li>• OSTM channel 2 interrupt handler (Interrupt ID: 90)</li> <li>• SCIFA channel 4 interrupt handler (Interrupt ID: 322 and 323)</li> </ul>
SCIFA	<p>Configure SCIFA channel 4 as asynchronous communication mode            Serial communication setting:</p> <ul style="list-style-type: none"> <li>• Data length: 8 bits</li> <li>• Stop bits: 1 bit</li> <li>• Parity: None</li> <li>• LSB-first transfer</li> </ul> <p>SCIFA is configured as follows in case of setting <math>P1\phi</math> to 66MHz:</p> <ul style="list-style-type: none"> <li>• Clock source: No frequency division</li> <li>• Baud rate generator: double-speed mode</li> <li>• Operating on the base clock with 8 times the bit rate</li> <li>• Configures the appropriate bit rate so that the baud rate can become 115200bps. Thus, the bit rate should become -0.53%</li> </ul>

### 5.2.2 Memory Mapping

Figure 5.2 shows RZ/A2M group address space and memory address map of RZ/A2M CPU board.

In the sample program, the code and data using ROM area is placed in the serial flash memory connected to SPI Multi I/O bus space, while the code and data are using RAM area is placed in the large-capacity on-chip RAM.

	RZ/A2M group Address space	CPU board for RZ/A2M Memory map
H'FFFF FFFF	Internal IO area and Reserved area (2044MB)	Internal IO area and Reserved area (2044MB)
H'8040 0000	Large-capacity on-chip RAM (4MB)	Large-capacity on-chip RAM (4MB)
H'8000 0000	Reserved area (256MB)	Reserved area (256MB)
H'7000 0000	OctaRAM™ space (256MB)	-
H'6100 0000	OctaFlash™ space (256MB)	-
H'5400 0000	HyperRAM™ space (256MB)	-
H'4080 0000	HyperFlash™ space (256MB)	HyperRAM™ (8MB)
H'4000 0000	HyperFlash™ space (256MB)	-
H'3400 0000	SPI multi I/O bus space (256MB)	HyperFlash™ (64MB)
H'3000 0000	Internal IO area and Reserved area (128MB)	-
H'2400 0000	CS5 space (64MB)	Serial flash memory (64MB)
H'2000 0000	CS4 space (64MB)	Internal IO area and Reserved area (128MB)
H'1800 0000	CS3 space (64MB)	-
H'1400 0000	CS2 space (64MB)	-
H'1000 0000	CS1 space (64MB)	-
H'0C00 0000	CS0 space (64MB)	-
H'0800 0000		
H'0400 0000		
H'0000 0000		

**Figure 5.2 Memory Mapping**

### 5.2.3 MMU Configuration

By using the descriptor type "Section" of first-level descriptors, the MMU is set to manage the 4 GB area in 1MB unit

from the address H'0000 0000 in response to the memory map of the hardware resource used for the RZ/A2M CPU board. Please note that MMU configuration table. (MMU\_SC\_TABLE[ ]) is defined in the file `r_mmu_drv_sc_cfg.h`. When customizing MMU configuration for your system, please specify 1MB as minimum unit.

Translation table for 1st level descriptor is configured by the Translation Table Base Control Register (TTBCR) and Translation Table Base Register 0 or 1 (TTBR0 or TTBR1). After all the translation tables are configured, MMU can be enabled by configuring the M bit in System Control Register (SCTLR). For details on MMU, please refer to "ARM Architecture Reference Manual ARMv7-A and ARMv7-R edition Issue C".

- TTBCR

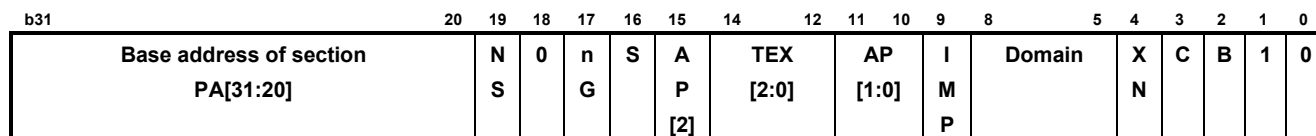
This register determines the base register (either TTBR0 or TTBR1) used as the base address for the translation table. Also, it determines the size of translation table specified by TTBR0. In the sample program, b'000 is specified for the N[2:0] bits so that TTBR0 can be always used and the size of translation table can become 16KB (i.e. 4096 entries).

As shown in Figure 5.3, the 1st level translation table and section descriptor format are used as translation table and 1st level descriptor respectively. When using section descriptor format, each entry of translation table becomes 1MB sized memory block, and the translation from virtual address to physical address using translation table is carried out against 4GB (4096 entries x 1MB) sized address space.

- TTBCR

This register specifies the base address of translation table, cacheable attributes for the region where translation table is located, etc. In the sample code, the base address is "`__mmu_page_table_base`" defined in the file `linker_script.ld`, which is the starting address of section area of translation table located in the large-capacity on-chip RAM.

Figure 5.3, Table 5.2 to Table 5.4 show the overview of 1st level descriptor and its configuration in the sample program respectively. Also, Table 5.5 and Table 5.6 show the MMU setting in the sample program.



**Figure 5.3 1st Level Descriptor Format when Specifying Section for Descriptor Type**

**Table 5.2 Fields of 1st Level Descriptor**

Field	Description
TEX[2:0], C, B	Memory region attribute bits Please refer to Table 5.3 on the configuration in the sample program
XN	Execute-never bit When setting this bit to 1, the instruction shouldn't be fetched from the memory area located in the domain specified as client. In the sample program, Normal region is configured as executable (i.e. XN = 1), while Strongly-ordered region is configured as non-executable (i.e. XN = 0).
Domain	2 types of domain access are supported. One is client mode and the other is manager mode. Domain access type is specified by Domain Access Control Register (DACR). In the sample program, D15 field of DACR is configured as b'01 (i.e. client access mode) and b'1111 (D15 field) is specified for all the spaces.
IMP	This is NOT implemented in RZ/A2M and therefore, the configuration of this bit is ignored.
AP[2], AP[1:0]	These field and the domain field determine if the access is enabled. In the sample program, the access to reserved area is disabled (i.e. AP[2:0] = b'000), while the access to all the other area is enabled (i.e. AP[2:0] = b'011).
S	Sharable bit that can determines if the memory area is sharable. In the sample program, All the Normal regions are configured as no-sharable area (i.e. S=0).
nG	The non-Global bit In the sample program, all the regions are configured as the global (i.e. nG = 0)
NS (Note)	The Non-Secure bit In the sample program, large-capacity on-chip RAM and external address space are configured as the Non-Secure space (i.e. NS=1), while internal peripheral module space is configured as the Secure space (i.e. NS=0).
PA[31:20]	MSB 12-bits of the physical address translated from virtual address

Note: For RZ/A2M, please configure CPU security state as the "Secure" (i.e. NS bit of Secure Configuration Register sets to 0). By getting CPU to configure "Secure", CPU can access all the area where its physical address is converted into virtual address using MMU regardless of NS bit setting. In the sample code, CPU accesses the large capacity on-chip RAM and external address space by setting NS bit to 1 on the basis that AXI bus related registers MSTACCCTL0, MSTACCCTL1, MSTACCCTL2, MSTACCCTL3 and MSTACCCTL4 and for on-chip peripheral modules are set as 1 (i.e. Non Secure Access). By default, MSTACCCTL0-4 registers are configured as 1.

**Table 5.3 Memory Attribute Setting in the Sample Program**

TEX[2:0]	C	B	Memory Type	L1 Cache	L2 Cache
b'000	0	0	Strongly-ordered	-	-
b'000	0	1	Device (sharable)	-	-
b'001	1	1	Normal memory	Enabled	Enabled
b'100	0	1	Normal memory	Enabled	Disabled
b'100	0	0	Normal memory	Disabled	Disabled

**Table 5.4 MMU Settings and Its Description**

Name of MMU settings	Memory type	Cache	N S	AP[2:0] (Access Permission)	X N
Unused	Strongly-ordered	-	1	Read/Write (b'011)	1
Strongly-ordered (Secure, Never-execute)	Strongly-ordered	-	0	Read/Write (b'011)	1
Strongly-ordered (Non-secure, Never-execute)	Strongly-ordered	-	1	Read/Write (b'011)	1
Strongly-ordered (Non-secure, Executable)	Strongly-ordered	-	1	Read/Write (b'011)	0
Sharable Device (Secure)	Device	-	0	Read/Write (b'011)	1
Sharable Device (Non-secure)	Device	-	1	Read/Write (b'011)	1
Normal (Non-secure, L1 cacheable)	Normal	Only L1 cache is enabled	1	Read/Write (b'011)	0
Normal (Non-secure, L2 cacheable)	Normal	Only L2 cache is enabled	1	Read/Write (b'011)	0
Normal (Non-secure, L1/L2 cacheable)	Normal	Both L1 and L2 are enabled	1	Read/Write (b'011)	0
Normal (Non-secure, Non-cacheable)	Normal	Both L1 and L2 are disabled	1	Read/Write (b'011)	0
Reserved	Strongly-ordered	-	1	Access Inhibit (b'000)	1



Table 5.5 MMU settings (1/2)

Virtual address	Physical address	Size	Address area	Name of MMU settings (Note)
H'0000 0000 H'03FF FFFF	H'0000 0000 H'03FF FFFF	64MB	CS0 area (Unused)	Unused
H'0400 0000 H'07FF FFFF	H'0400 0000 H'07FF FFFF	64MB	CS1 area (Unused)	Unused
H'0800 0000 H'0BFF FFFF	H'0800 0000 H'0BFF FFFF	64MB	CS2 area (Unused)	Unused
H'0C00 0000 H'0FFF FFFF	H'0C00 0000 H'0FFF FFFF	64MB	CS3 area Cacheable	Normal (Non-secure, L1/L2 cacheable)
H'1000 0000 H'13FF FFFF	H'1000 0000 H'13FF FFFF	64MB	CS4 area (Unused)	Unused
H'1400 0000 H'17FF FFFF	H'1400 0000 H'17FF FFFF	64MB	CS5 area (Unused)	Unused
H'1800 0000 H'1EFF FFFF	H'1800 0000 H'1EFF FFFF	112MB	Reserved	Reserved
H'1F00 0000 H'1FFF FFFF	H'1F00 0000 H'1FFF FFFF	16MB	Internal I/O area	Strongly-ordered (Secure, Never-execute)
H'2000 0000 H'2FFF FFFF	H'2000 0000 H'2FFF FFFF	256MB	SPI Multi I/O bus area Cacheable	Normal (Non-secure, L1/L2 cacheable)
H'3000 0000 H'3FFF FFFF	H'3000 0000 H'3FFF FFFF	256MB	HyperFlash Cacheable	Normal (Non-secure, L1/L2 cacheable)
H'4000 0000 H'4FFF FFFF	H'4000 0000 H'4FFF FFFF	256MB	HyperRAM Cacheable	Normal (Non-secure, L1/L2 cacheable)
H'5000 0000 H'5FFF FFFF	H'5000 0000 H'5FFF FFFF	256MB	OctaFlash Cacheable	Normal (Non-secure, L1/L2 cacheable)
H'6000 0000 H'6FFF FFFF	H'6000 0000 H'6FFF FFFF	256MB	OctaRAM Cacheable	Normal (Non-secure, L1/L2 cacheable)
H'7000 0000 H'7FFF FFFF	H'2000 0000 H'2FFF FFFF	256MB	SPI Multi I/O bus area Non-cacheable	Strongly-ordered (Non-secure, Executable)
H'8000 0000 H'803F FFFF	H'8000 0000 H'803F FFFF	4MB	Large-capacity on-chip RAM Cacheable	Normal (Non-secure, L1/L2 cacheable)

Table 5.6 MMU settings (2/2)

Virtual address	Physical address	Size	Address area	Name of MMU settings (Note)
H'8040 0000 H'81FF FFFF	H'8040 0000 ~ H'81FF FFFF	28MB	Reserved	Unused
H'8200 0000 H'823F FFFF	H'8000 0000 H'803F FFFF	4MB	Large-capacity on-chip RAM Non-cacheable	Normal (Non-secure, Non-cacheable)
H'8240 0000 H'87FF FFFF	H'8240 0000 H'87FF FFFF	92MB	Reserved	Unused
H'8800 0000 H'8BFF FFFF	H'0000 0000 H'03FF FFFF	64MB	CS0 area (Unused)	Unused
H'8C00 0000 H'8FFF FFFF	H'0400 0000 H'07FF FFFF	64MB	CS1 area (Unused)	Unused
H'9000 0000 H'93FF FFFF	H'0800 0000 H'0BFF FFFF	64MB	CS2 area (Unused)	Unused
H'9400 0000 H'97FF FFFF	H'0C00 0000 H'0FFF FFFF	64MB	CS3 area Non-cacheable	Normal (Non-secure, Non-cacheable)
H'9800 0000 H'9BFF FFFF	H'1000 0000 H'13FF FFFF	64MB	CS4 area (Unused)	Unused
H'9C00 0000 H'9FFF FFFF	H'1400 0000 H'17FF FFFF	64MB	CS5 area (Unused)	Unused
H'A000 0000 H'AFF FFFF	H'3000 0000 H'3FFF FFFF	256MB	HyperFlash Non-cacheable	Strongly-ordered (Non-secure, Executable)
H'B000 0000 H'BFFF FFFF	H'4000 0000 H'4FFF FFFF	256MB	HyperRAM Non-cacheable	Normal (Non-secure, Non-cacheable)
H'C000 0000 H'CFFF FFFF	H'5000 0000 H'5FFF FFFF	256MB	OctaFlash Non-cacheable	Strongly-ordered (Non-secure, Non-cacheable)
H'D000 0000 H'DFFF FFFF	H'6000 0000 H'6FFF FFFF	256MB	OctaRAM Non-cacheable	Normal (Non-secure, Non-cacheable)
H'E000 0000 H'E7FF FFFF	H'E000 0000 H'E7FF FFFF	128MB	Reserved	Reserved
H'E800 0000 H'FFFF FFFF	H'E800 0000 H'FFFF FFFF	384MB	Internal I/O area	Strongly-ordered (Secure, Never-execute)

Notes: 1. Regarding the relationship between MMU settings and the corresponding name, please refer to Table 5.3 and Table 5.4.

2. Physical address is written in red when virtual address is different from the corresponding physical address.

### 5.2.4 Virtual Address Space in Sample Program

Table 5.5 and Table 5.6 show the virtual address space which is configured using MMU and accessible from CPU.

RZ/A2M group Address space		Virtual address space in sample code	
H'803F FFFF	Large-capacity on-chip RAM (4MB)	H'803F FFFF	Cacheable area in Large-capacity on-chip RAM (4MB)
H'8000 0000	Reserved area (256MB)	H'8000 0000	Non-cacheable area in SPI multi I/O bus space (256MB)
H'7000 0000		H'7000 0000	
	OctaRAM space (256MB)		Cacheable area in OctaRAM (256MB)
H'6000 0000		H'6000 0000	
	OctaFlash space (256MB)		Cacheable area in OctaFlash (256MB)
H'5000 0000		H'5000 0000	
	HyperRAM space (256MB)		Cacheable area in HyperRAM (256MB)
H'4000 0000		H'4000 0000	
	HyperFlash space (256MB)		Cacheable area in HyperFlash (256MB)
H'3000 0000		H'3000 0000	
	SPI multi I/O bus space (256MB)		Cacheable area in SPI multi I/O bus space (256MB)
H'2000 0000		H'2000 0000	
H'1F00 0000	Internal IO area (16MB)	H'1F00 0000	Internal IO area (16MB)
H'1800 0000	Reserved area (112MB)	H'1800 0000	Reserved area (112MB)
	CS5 space (64MB)		CS5 space (64MB) (Unused)
H'1400 0000		H'1400 0000	
	CS4 space (64MB)		CS4 space (64MB) (Unused)
H'1000 0000		H'1000 0000	
	CS3 space (64MB)		Cacheable area in CS3 space (64MB)
H'0C00 0000		H'0C00 0000	
	CS2 space (64MB)		CS2 space (64MB) (Unused)
H'0800 0000		H'0800 0000	
	CS1 space (64MB)		CS1 space (64MB) (Unused)
H'0400 0000		H'0400 0000	
	CS0 space (64MB)		CS0 space (64MB) (Unused)
H'0000 0000		H'0000 0000	

Figure 5.4 Virtual Address Space in the Sample Program (1/2)

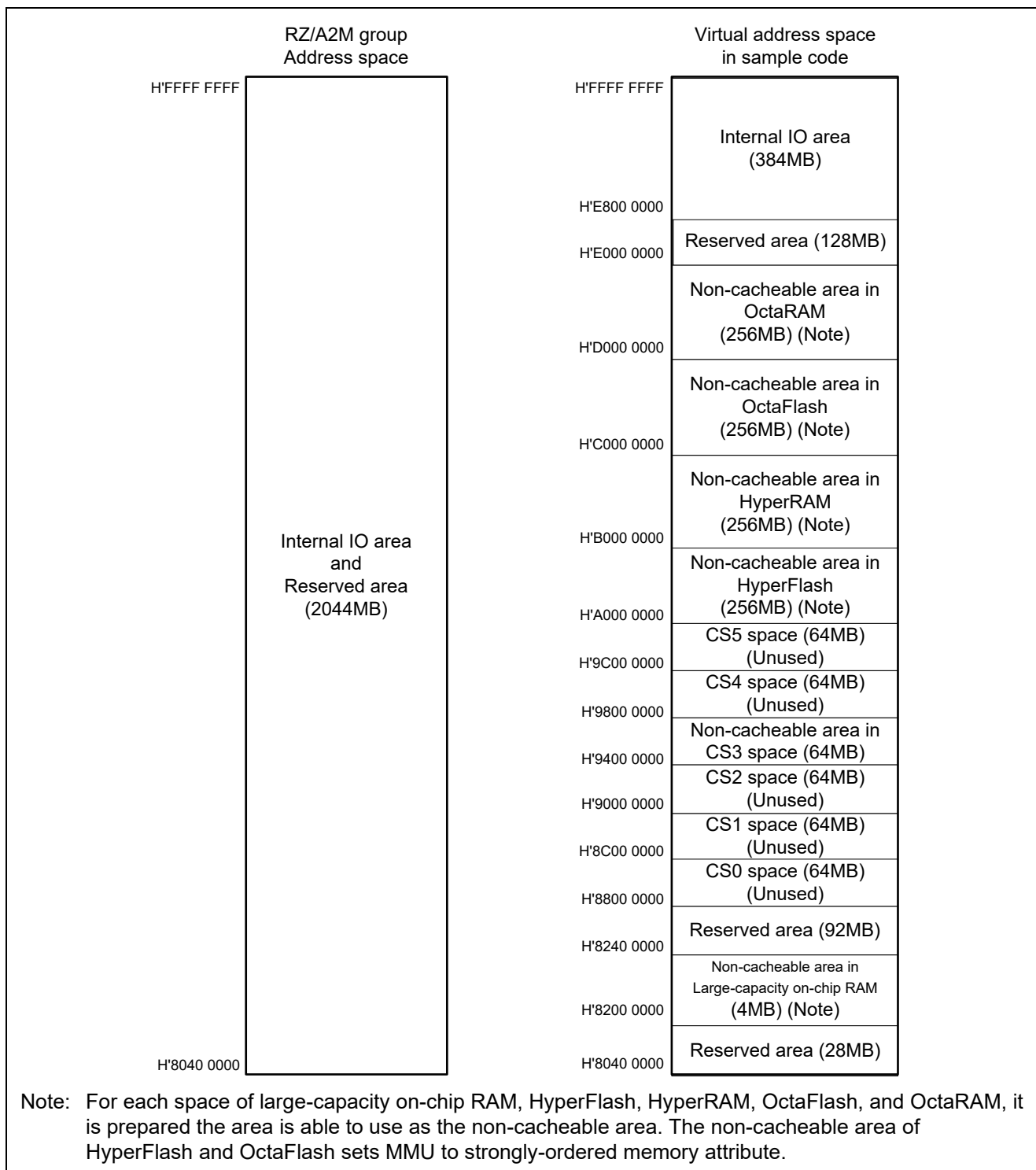


Figure 5.5 Virtual Address Space in the Sample Program (2/2)

### 5.2.5 Section setup in the sample program

In this sample code, the exception processing vector table and the IRQ interrupt handler are assigned to the large-capacity on-chip RAM, and they are executed in such RAM to speed up the interrupt processing. The transfer processing from the serial flash memory area which is the program code of the exception processing vector table and the IRQ interrupt handler to the large-capacity on-chip RAM area, the clear to zero processing for the data section without initial data, and the initialization for the data section with initial data are executed by INTSCT function. The INTSCT function refer to the table data for section initialization defined in the file section.c and initialize each section. The assignment of program data is described in the linker script (linker\_script.ld).

Table 5.7 list the Sections to be Used in the sample code. Figure 5.3 shows the Section Assignment for the initial condition of the sample code and the condition after using INTSCT function.

Table 5.7 Memory Area to be used

Output section Name	Input section Name Input Object Name	Description	Loading Area	Execution Area
LOAD_MODULE1	VECTOR_TABLE	Exception processing vector table	FLASH	FLASH
LOAD_MODULE2	* /r_cpg/* .o (.text .rodata .data)	Program code area for CPG	FLASH	LRAM
	* /rza_io_regrw.o (.text .rodata .data)	Program code area for function of I/O register access		
	* /hwsetup* .o (.text .rodata .data)	HardwareSetup setting processing		
LOAD_MODULE3	* /r_cpg* .o (.bss)	Data area without initial value for CPG	-	LRAM
	* /rza_io_regrw.o (.bss)	Data area without initial value for function of I/O register access		
LOAD_MODULE4	RESET_HANDLER	Program code area of reset handler processing	FLASH	FLASH
	INIT_SECTION */sections.o	Program code area of section initialization processing		
.data	VECTOR_MIRROR_TABLE	Exception processing vector table	FLASH	LRAM
	* /r_intc* .o (.text .rodata .data)	Program code area for INTC Driver		
	IRQ_FIQ_HANDLER	IRQ/FIQ handler processing		
.bss	none	none	-	LRAM
.uncached_RAM	* /r_cache* .o (.bss)	Data area without initial value for setting the L1 and L2 caches (see Note2)	-	LRAM
	UNCACHED_BSS	Data area without initial value for buffer.		
.uncached_RAM2	* /r_cache* .o (.text .rodata .data)	Program code area for setting the L1 and L2 caches (see Note2)	FLASH	LRAM
	UNCACHED_DATA	Data area without initial value for buffer.		
.mmu_page_table	none	MMU translation table area	-	LRAM
.stack	none	Stack area for system mode Stack area for IRQ mode Stack area for FIQ mode Stack area for supervisor(SVC) mode Stack area for abort(ABT) mode	-	LRAM
.text2	* (.text .text.*)	Program code area for defaults	FLASH	FLASH
	* (.rodata .rodata.*)	Constant data area for defaults		
.data2	* (.data .data.*)	Data area with initial value for defaults	FLASH	LRAM
.bss2	* (.bss .bss.*) * (COMMON)	Data area without initial value for defaults	-	LRAM
.heap	none	Heap area	-	LRAM

Notes: 1. "FLASH" and "LRAM" shown in "Loading Area" and "Execution Area" indicate the serial flash memory area and the large-capacity on-chip RAM area respectively.

2. This section should be placed in the cache-disabled area.

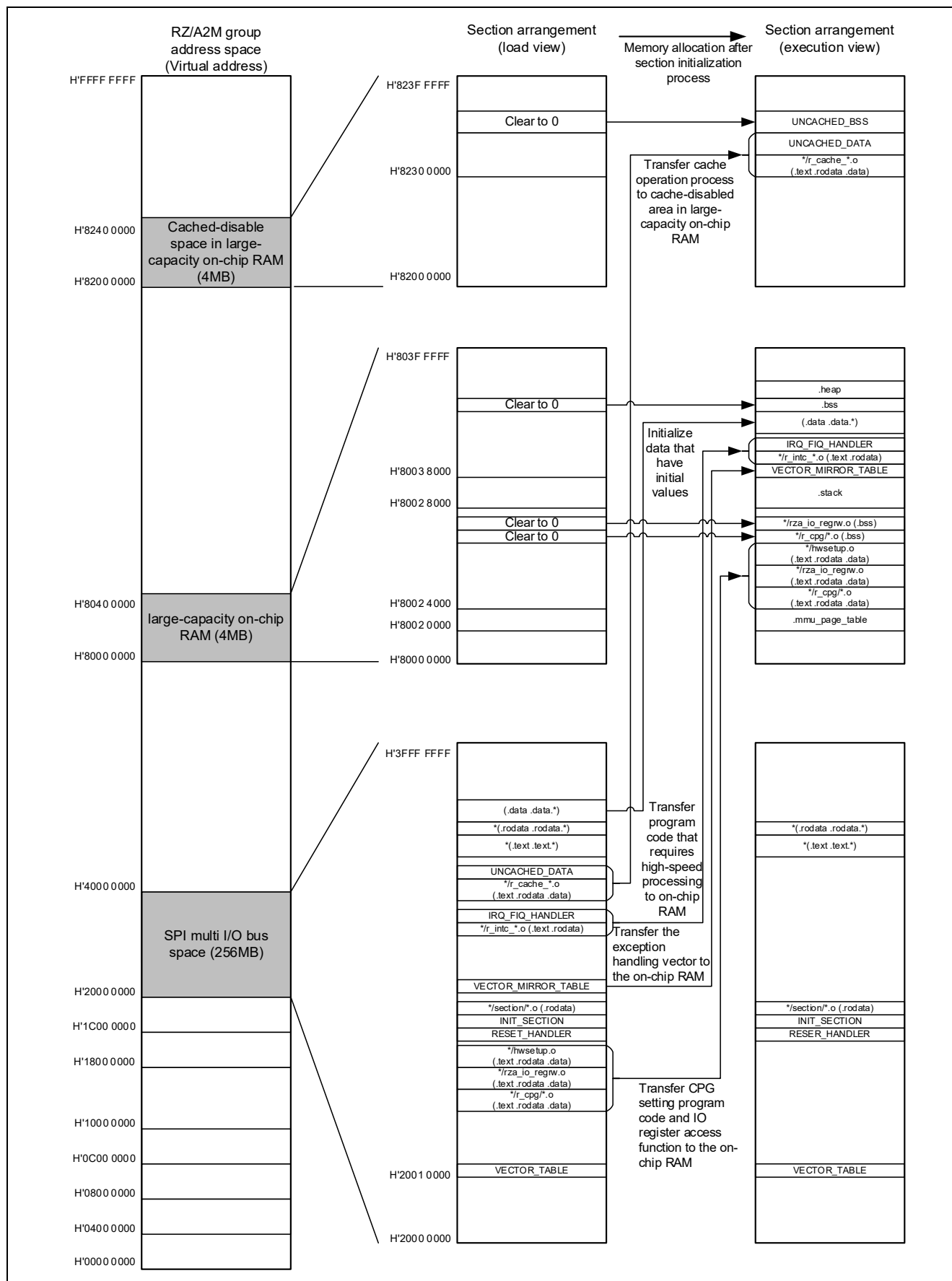
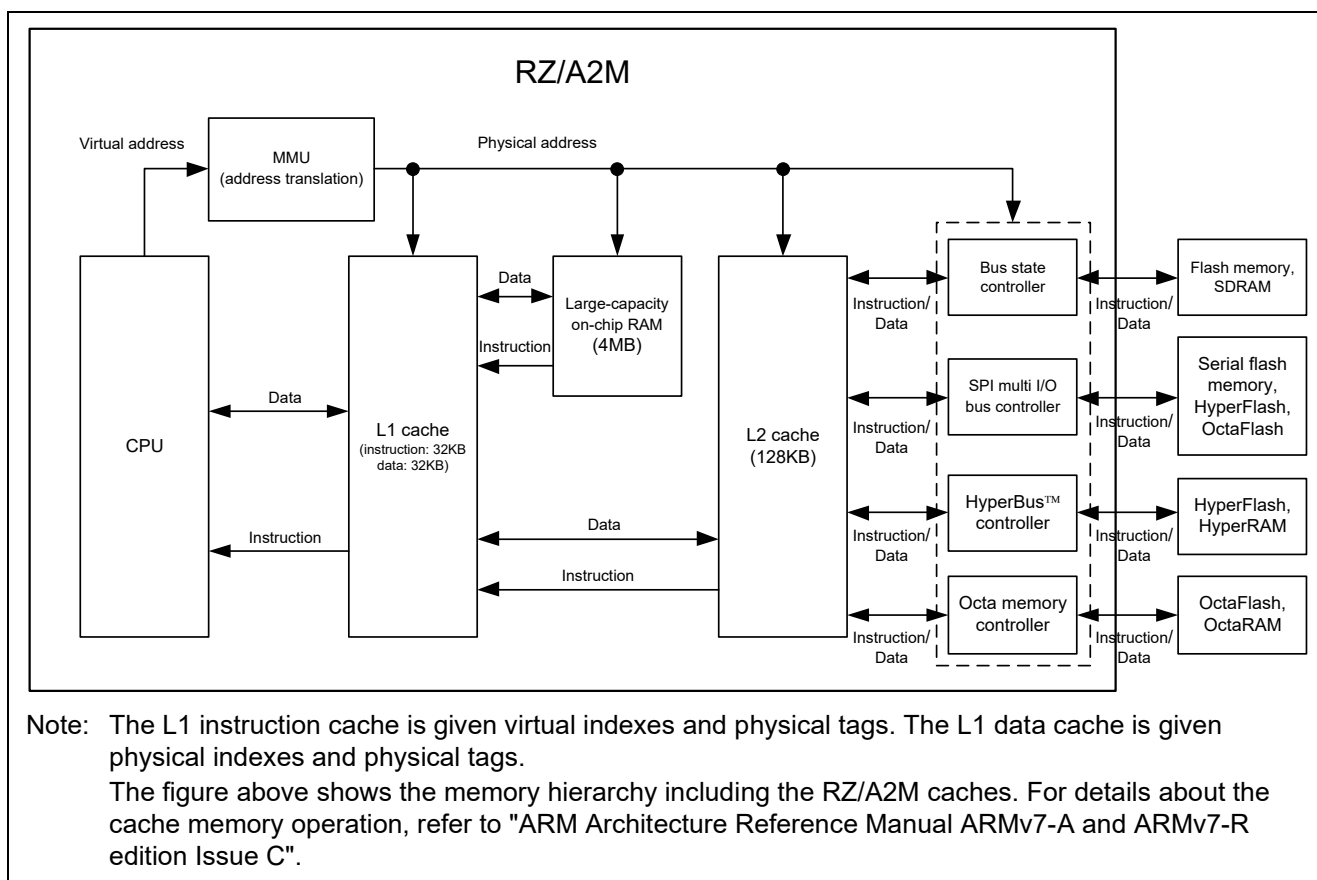


Figure 5.6 Section Assignment

### 5.2.6 L1 and L2 Cache Settings

RZ/A2M has two types of cache, L1 cache and L2 cache. L1 cache consists of 32Kbyte instruction cache and 32Kbyte data cache, while L2 cache consists of 128Kbyte cache which is commonly used for instruction and data.

Figure 5.7 shows the Block Diagram of L1 and L2 cache in memory Hierarchy.



**Figure 5.7 Block Diagram of L1 and L2 cache in memory Hierarchy**

When accessing external memory space or on-chip large-capacity RAM from CPU, the virtual address is translated to the physical address using the 1st level descriptor for MMU translation table. As shown in Figure 5.3, the cache behavior of memory area whose base address and size are determined by the 1st level descriptor should also be specified by the 1st level descriptor. Please note that the size of area should be 1MB when "Section" is specified as 1st level descriptor type. For RZ/A2M, cache behavior of both external memory spaces (CS0 to CS5, SPI Multi I/O Bus space, HyperFlash/HyperRAM space and OctaFlash/OctaRAM space) and on-chip memory space (such as on-chip large-capacity RAM, on-chip peripheral module and reserved area) should be set up by MMU translation table.



Enabling/Disabling cache is controlled by the registers stated below:

- CP15 System Control Register (SCTLR) : I bit (b12), C bit (b2)  
I bit "0" denotes instruction cache is disabled, while "1" denotes instruction cache is enabled  
C bit "0" denotes data cache is disabled, while "1" denotes data cache is enabled  
Please note that SCTLR has M bit (b0) which enables/disables MMU ("1" denotes MMU is enabled)
- Control Register (reg1\_control) : L2 Cache enable bit (b0)  
L2 Cache enable bit "0" denotes L2 Cache is disabled, while "1" denotes L2 Cache is enabled  
Please note that reg1\_control is the register implemented in CoreLink level2 cache controller (L2C-310).

- Notes:
1. Before enabling L1 instruction cache and L1 data cache, it is necessary to invalidate L1 instruction cache, L1 data cache and TLB with MMU, L1 instruction cache and L1 data cache disabled.  
Before enabling L2 cache, it is necessary to invalidate L2 cache as L1 cache do.
  2. Direct Memory Access Controller (DMAC) shouldn't access to memory via L1 cache, while L2 cache is enabled. So, if both CPU and DMAC may access the shared area where L1 cache is enabled, user application should execute appropriate cache operation to care about cache coherency before kicking DMAC.

Figure 5.8 and 5.9 shows how L1 and L2 cache are initialized respectively.

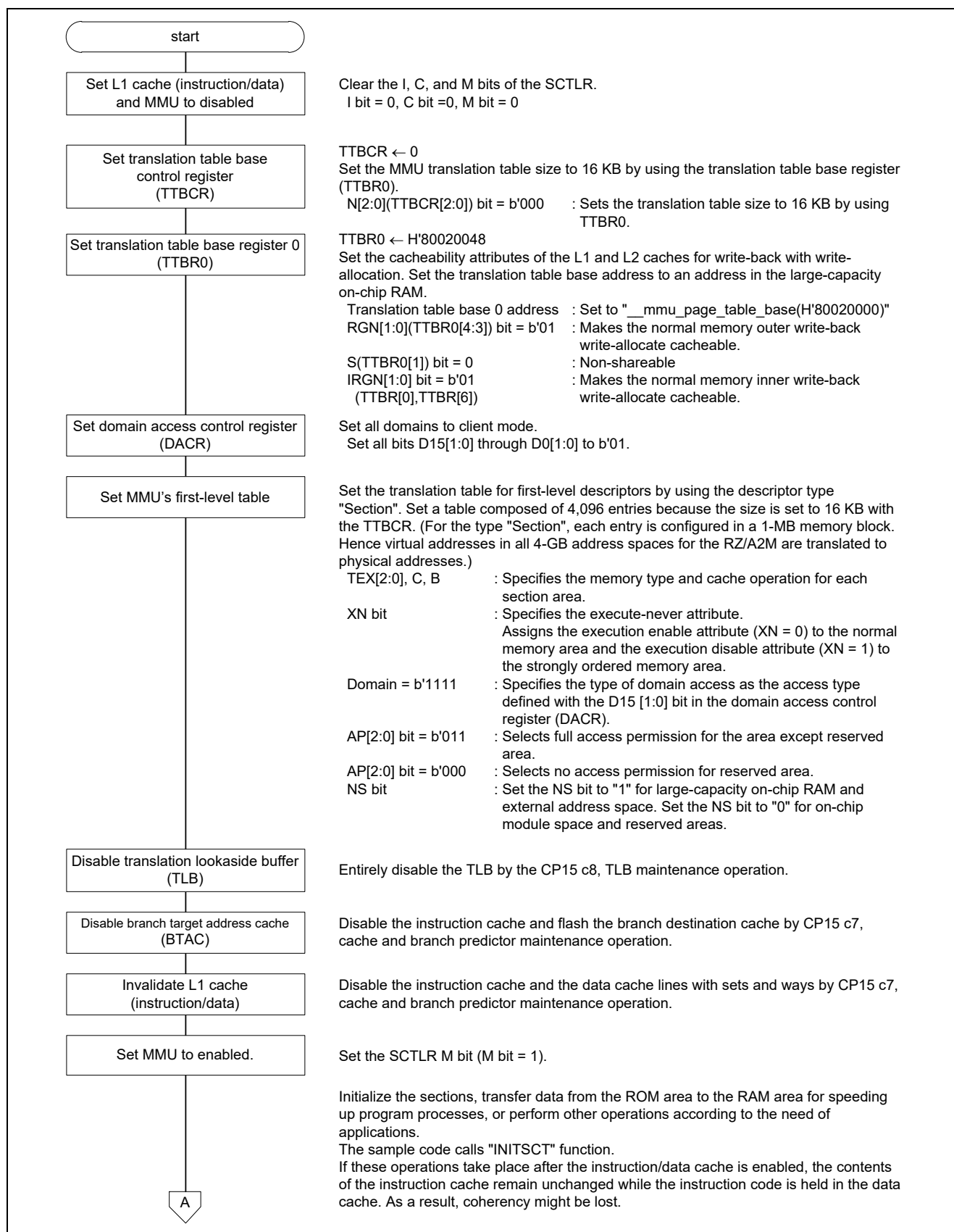
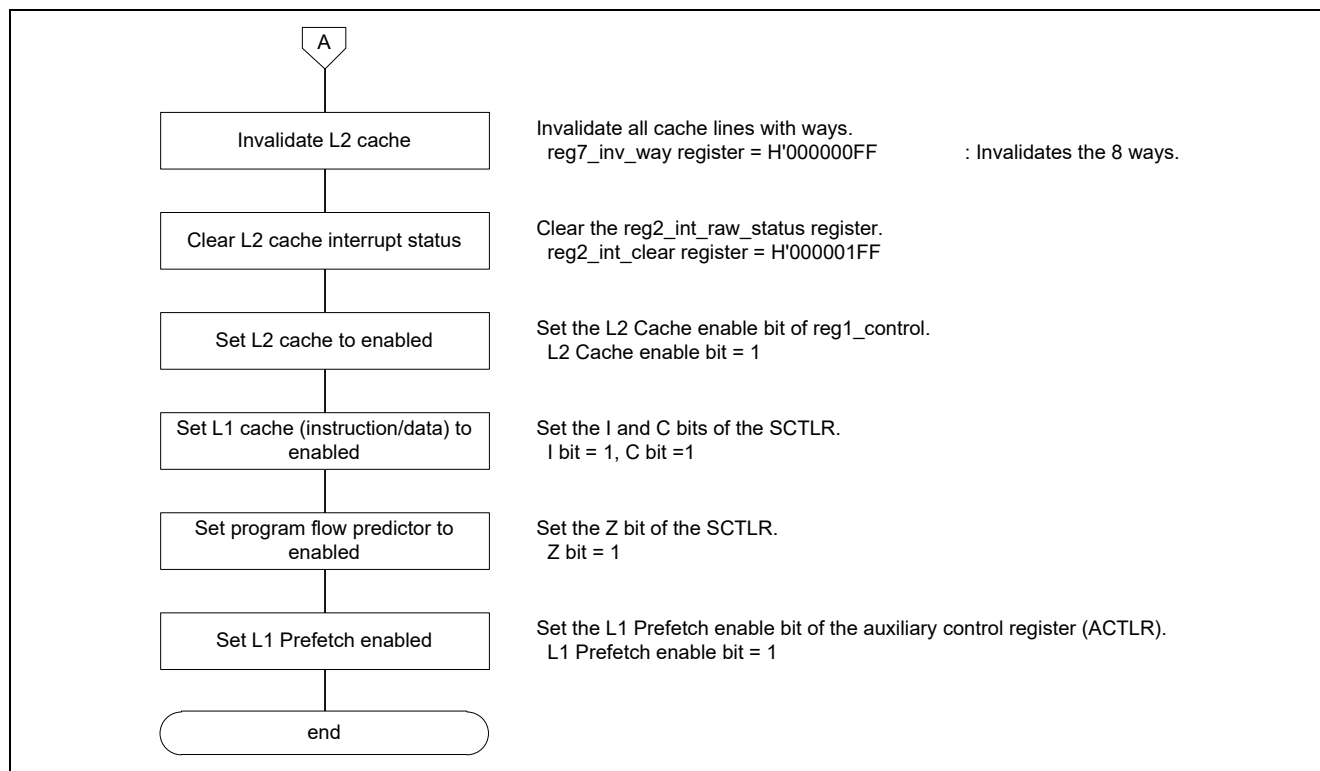


Figure 5.8 Flow of L1 and L2 Cache Initial Setup (1/2)

**Figure 5.9 Flow of L1 and L2 Cache Initial Setup (2/2)**

### 5.2.7 Exception Vector Table

On RZ/A2M, the 7 types of exception (i.e. reset exception, undefined instruction exception, software interrupt exception, prefetch abort exception, data abort exception, IRQ exception and FIQ exception) might occur.

In the sample program, the processing of application program sets VBAR to the address indicated by "\_\_vector\_mirror\_table\_base" after switching Low vector, then the exception processing vector table is assigned to the area from the start address "\_\_vector\_mirror\_table\_base" to the area of 32 bytes. And the branch instruction to each exception should be described in the exception vector table.

Figure 5.9 shows the exception vector table implemented in the sample program for your reference.

```
vector_table2:
  LDR pc, =reset_handler      ; +0x0000_0000 : Reset exception
  LDR pc, =undefined_handler ; +0x0000_0004 : Undefined instructions exception
  LDR pc, =svc_handler        ; +0x0000_0008 : Software interrupts exception
  LDR pc, =prefetch_handler   ; +0x0000_000C : Prefetch abort exception
  LDR pc, =abort_handler      ; +0x0000_0010 : Data abort exception
  LDR pc, =reserved_handler   ; +0x0000_0014 : Reserved
  LDR pc, =irq_handler        ; +0x0000_0018 : IRQ exception
  LDR pc, =fiq_handler        ; +0x0000_001C : FIQ exception
```

**Figure 5.10 Example of Exception Vector Table Implementation**

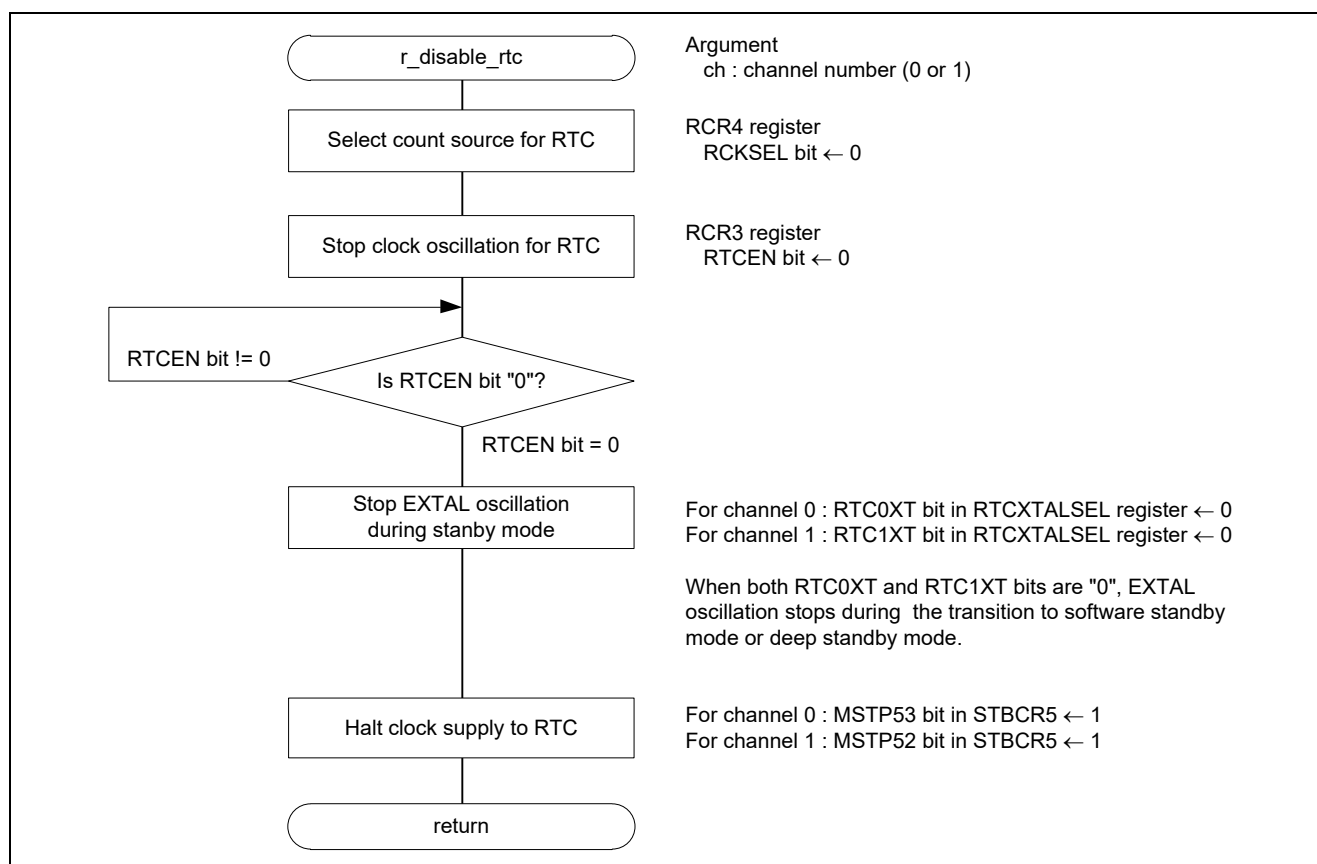
### 5.2.8 Processing for RTC and USB unused channel

In the sample program, the processing for RTC and USB unused channel is implemented at the top of resetprg function to reduce power consumption. The macro definition listed in Table 5.8 determines if the processing for unused processing is carried out.

**Table 5.8 Macro Definition for Selecting RTC and USB Channel to be Used**

Macro definition	Settings	Description
STARTUP_CFG_DISABLE_RTC0	0	RTC channel 0 is used
	1 (Default)	RTC channel 0 is NOT used
STARTUP_CFG_DISABLE_RTC1	0	RTC channel 1 is used
	1 (Default)	RTC channel 1 is NOT used
STARTUP_CFG_DISABLE_USB0	0	USB channel 0 is used
	1 (Default)	USB channel 0 is NOT used
STARTUP_CFG_DISABLE_USB1	0	USB channel 1 is used
	1 (Default)	USB channel 1 is NOT used

Figure 5.11 shows the Processing Flow for RTC Unused Channel.



**Figure 5.11 Processing Flow for RTC Unused Channel**

Figure 5.12 shows the Processing Flow for USB Unused Channel.

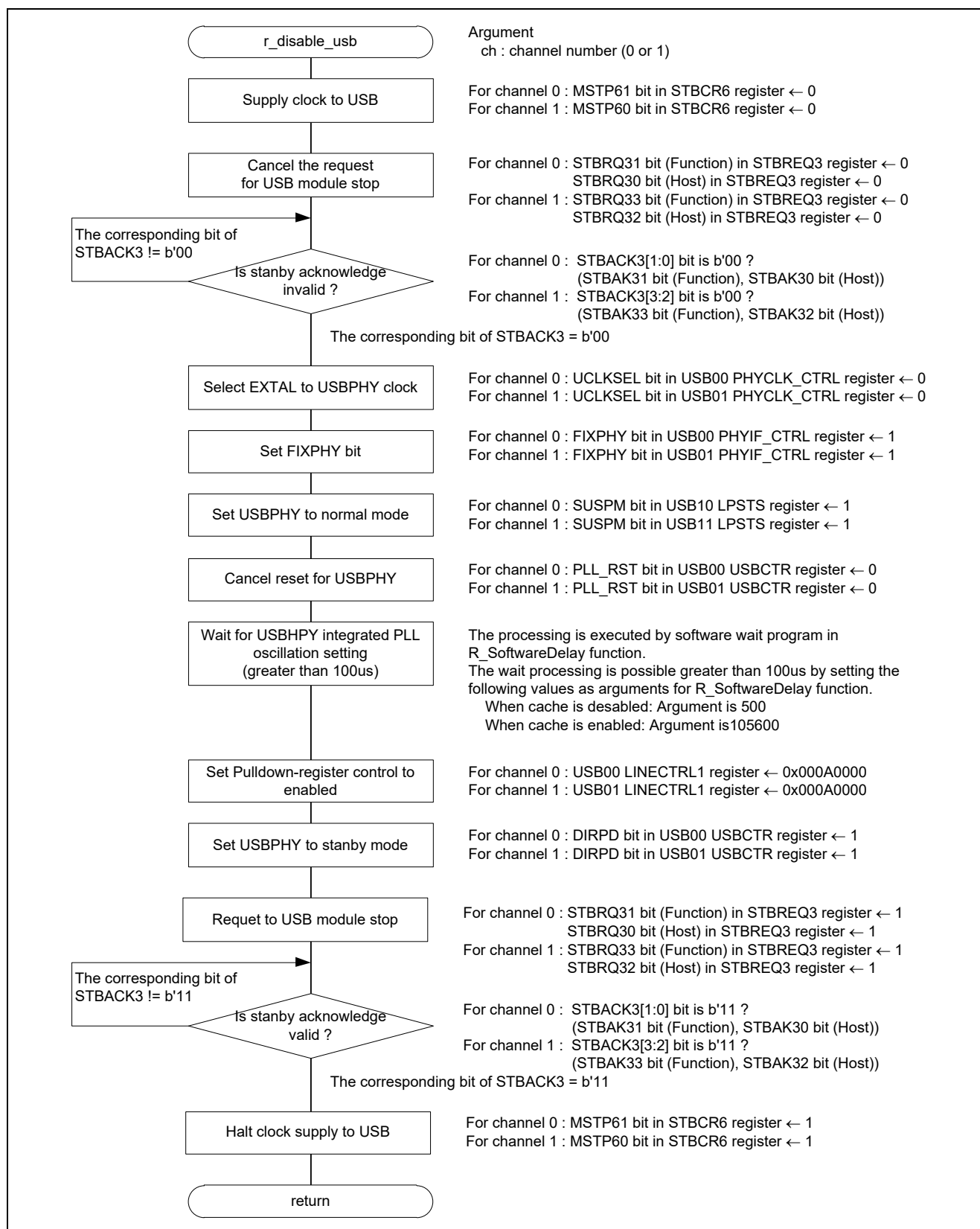


Figure 5.12 Processing Flow for USB Unused Channel

### 5.3 Interrupts Used

Table 5.9 shows the Interrupts Used in Sample Program.

**Table 5.9 Interrupts Used in Sample Program**

Interrupt Source (Interrupt ID)	Priority	Processing Outline
OSTM0 (88)	3	Generate interrupt every 500ms
OSTM2 (90)	30	Generate interrupt every 1ms
RXI4 (322)	30	Generate SCIFA's RXI4 interrupt
TXI4 (323)	30	Generate SCIFA's TXI4 interrupt

### 5.4 Fixed-Width Integers

Table 5.10 shows the Fixed-Width Integers Used in the Sample Program.

**Table 5.10 Fixed-Width Integers Used in the Sample Program**

Symbol	Description
char_t	8-bits character
bool_t	Boolean type. Allowable value is true (1) or false (0)
int_t	High-speed signed integer. In the sample code, its width is 32-bits
int8_t	Signed 8-bits integer (declared in the standard library stdint.h)
int16_t	Signed 16-bits integer (declared in the standard library stdint.h)
int32_t	Signed 32-bits integer (declared in the standard library stdint.h)
int64_t	Signed 64-bits integer (declared in the standard library stdint.h)
uint8_t	Unsigned 8-bits integer (declared in the standard library stdint.h)
uint16_t	Unsigned 16-bits integer (declared in the standard library stdint.h)
uint32_t	Unsigned 32-bits integer (declared in the standard library stdint.h)
uint64_t	Unsigned 64-bits integer (declared in the standard library stdint.h)
float32_t	32-bit floating point
float64_t	64-bit floating point
float128_t	128-bit floating point

## 5.5 Constants

Table 5.11 to Table 5.14 shows the Table 5.11 Constants Used in Sample Program.

**Table 5.11 Constants Used in Sample Program**

Constants Name	Setting Value	Description
MAIN_PRV_LED_ON	(1)	LED is ON
MAIN_PRV_LED_OFF	(0)	LED is OFF

**Table 5.12 Constants Used by GPIO Driver (1)**

Constants Name	Setting Value of GPIO				Description
	PMR	PDR	PODR	PSEL	
GPIO_FUNC_HIZ	0	b'00	-	-	Set pin assignment to no use (Hi-Z)
GPIO_FUNC_IN	0	b'10	1	-	Set pin assignment to general purpose input function
GPIO_FUNC_OUT_HIGH	0	b'11	0	-	Set pin assignment to general purpose out function(High Level)
GPIO_FUNC_OUT_LOW	0	b'11	-	-	Set pin assignment to general purpose out function(Low Level)
GPIO_FUNC_OUT_PERIPHERAL0	1	b'00	-	0	Set pin assignment to peripheral function 0
GPIO_FUNC_OUT_PERIPHERAL1	1	b'00	-	1	Set pin assignment to peripheral function 1
GPIO_FUNC_OUT_PERIPHERAL2	1	b'00	-	2	Set pin assignment to peripheral function 2
GPIO_FUNC_OUT_PERIPHERAL3	1	b'00	-	3	Set pin assignment to peripheral function 3
GPIO_FUNC_OUT_PERIPHERAL4	1	b'00	-	4	Set pin assignment to peripheral function 4
GPIO_FUNC_OUT_PERIPHERAL5	1	b'00	-	5	Set pin assignment to peripheral function 5
GPIO_FUNC_OUT_PERIPHERAL6	1	b'00	-	6	Set pin assignment to peripheral function 6
GPIO_FUNC_OUT_PERIPHERAL7	1	b'00	-	7	Set pin assignment to peripheral function 7

**Table 5.13 Constants Used by GPIO Driver (2)**

Constants Name	PmnPFS.ISEL Setting	Description
GPIO_TINT_DISABLE	0	Disable Pin interrupts function
GPIO_TINT_ENABLE	1	Enable Pin interrupts function
GPIO_TINT_RESERVED	-	Macro definition when using pin that can not use pin interrupts function

**Table 5.14 Constants Used by GPIO Driver (3)**

Constants Name	DSCR Setting	Description
GPIO_CURRENT_8mA	0	Set the pin drive strength to 8mA
GPIO_CURRENT_4mA	1	Set the pin drive strength to 4mA
GPIO_CURRENT_RESERVED	-	Macro definition when using pin that can not set drive strength



## 5.6 Functions

The sample code consists of the following functions:

- API function for using peripheral functions
- User Defined Function depending on user system for which user need to prepare (Functions called by API function)
- Sample Function implemented for getting sample program to be worked as a reference

In the sample code, the IO register-write and register-read function is used when accessing peripheral IO registers in bit unit.

Table 5.15 lists the Sample Functions. Table 5.16 and Table 5.17 list the API Functions. Table 5.18 lists the User Defined Functions.

**Table 5.15 Sample Functions**

Function Name	Description
reset_handler	Reset handler processing
resetprg	Initial setting of peripheral functions (Initial setting of INTC, L1 and L2 cache)
INITSCT	Initialize section
R_SC_HardwareSetup	Initial setting of peripheral functions
main	Main processing
irq_handler	IRQ handler processing
INTC_Handler_Interrupt	INTC interrupt handler processing
fiq_handler	FIQ handler processing
NMI_Handler_Interrupt	NMI interrupt handler processing
direct_open	Open the peripheral I/O driver function
direct_close	Close the peripheral I/O driver function
direct_read	Read the peripheral I/O driver function
direct_write	Write the peripheral I/O driver function
direct_control	Control the peripheral I/O driver function
direct_get_version	Get version information of the peripheral I/O driver
Sample_LED_Blink	OSTM channel 0 interrupt processing
r_disable_rtc	Setting process of unused channel of RTC
r_disable_usb	Setting process of unused channel of USB

**Table 5.16 API Functions (1/2)**

Function Name	Description
R_MMU_Init	Initial setting of the translation table of the MMU
R_MMU_WriteTbl	Configure MMU translation table
R_MMU_ReadTbl	Read MMU translation table
R_MMU_VAtoPA	Tranlate virtual address to physical address
R_CACHE_L1Init	Initialization of the L1 cache
R_CACHE_L1InstEnable	Setting the L1 instruction cache to enabled
R_CACHE_L1InstDisable	Setting the L1 instruction cache to disabled
R_CACHE_L1InstInvalidAll	Invalidate all L1 instruction cache lines
R_CACHE_L1DataEnable	Setting the L1 data cache to enabled
R_CACHE_L1DataDisable	Setting the L1 data cache to disabled
R_CACHE_L1DataInvalidAll	Invalidate all L1 data cache lines
R_CACHE_L1DataCleanAll	Clean all L1 data cache lines
R_CACHE_L1DataCleanInvalidAll	Clean&Invalidate all L1 data cache lines
R_CACHE_L1DataInvalidLine	Invalidate L1 data cache on cache lines (32 byte) basis
R_CACHE_L1DataCleanLine	Clean L1 data cache on cache lines (32 byte) basis
R_CACHE_L1DataCleanInvalidLine	Clean&Invalidate L1 data cache on cache lines (32 byte) basis
R_CACHE_L1BtacEnable	Setting the program predictor to enabled
R_CACHE_L1BtacDisable	Setting the program flow predictor to disabled
R_CACHE_L1BtacInvalidate	Invalidate all entries of the program flow predictor.
R_CACHE_L1PrefetchEnable	Setting the L1 prefetcher to enabled
R_CACHE_L1PrefetchDisable	Setting the L1 prefetcher to disabled
R_CACHE_L2Init	Initialization of the L2 cache
R_CACHE_L2CacheEnable	Setting the L2 cache to enabled
R_CACHE_L2CacheDisable	Setting the L2 cache to disabled
R_CACHE_L2InvalidAll	Invalidate all L2 caches
R_CACHE_L2CleanAll	Clean all L2 cache
R_CACHE_L2CleanInvalidAll	Clean&Invalidate all L2 cache
R_INTC_Init	Initialization of INTC
R_INTC_Enable	INTC interrupt enable
R_INTC_Disable	INTC interrupt disable
R_INTC_SetPriority	Setting for INTC interrupt priority level
R_INTC_SetMaskLevel	Setting for INTC interrupt mask level
R_INTC_GetMaskLevel	Obtaining INTC interrupt mask level
R_INTC_RegistIntFunc	Registration of INTC interrupt handler function
R_STB_StartModule	Canceling Module Standby
R_STB_StopModule	Transition to Module Standby

**Table 5.17 API Functions (2/2)**

Function Name	Description
R_CPG_InitialiseHwlf	Initialization process of CPG
R_GPIO_HWInitialise	Initialization process of GPIO
R_GPIO_InitByPinList	GPIO setting by pin list
R_GPIO_InitByTable	GPIO setting by GPIO configuration table
R_GPIO_PinWrite	Setting the pin output level
R_GPIO_PinRead	Getting the pin input level
RZA_IO_RegWrite_8	I/O register write function (For I/O register accessible by 8 bits)
RZA_IO_RegWrite_16	I/O register write function (For I/O register accessible by 16 bits)
RZA_IO_RegWrite_32	I/O register write function (For I/O register accessible by 32 bits)
RZA_IO_RegRead_8	I/O register read function (For I/O register accessible by 8 bits)
RZA_IO_RegRead_16	I/O register read function (For I/O register accessible by 16 bits)
RZA_IO_RegRead_32	I/O register read function (For I/O register accessible by 32 bits)

**Table 5.18 User Defined Functions**

Function Name	Description
Userdef_INTC_Pre_Interrupt	Callback function that before interrupt handler processing is executed
Userdef_INTC_Post_Interrupt	Callback function that after interrupt handler processing is executed
Userdef_INTC_UndefId	Processing when accepting unsupported interrupt ID of INTC interrupt
Userdef_INTC_UnregisteredID	Processing when INTC interrupt handler accepts unregistered ID
Userdef_PreHardwareSetup	Processing to be performed before executing hardware initialization
Userdef_PostHardwareSetup	Processing to be performed after executing hardware initialization

## 5.7 Function Specification

This section describes the specification of function in the sample code.

<b>reset_handler</b>	
<b>Overview</b>	Reset handler processing
<b>Syntax</b>	reset_handler FUNCTION {}
<b>Description</b>	This is the assembler function invoked just after reset is canceled. This function carries out the initial setup of stack pointer, peripherals needed minimally after reset is canceled and MMU and then, resetprg is called.
<b>Parameters</b>	None
<b>Return value</b>	None
<b>resetprg</b>	
<b>Overview</b>	Initial setting of peripheral functions (Initial setting of INTC, L1 and L2 cache)
<b>Syntax</b>	void resetprg(void)
<b>Description</b>	Initialize INTC and L1/L2 Cache and then, call the function main.
<b>Parameters</b>	None
<b>Return value</b>	None
<b>INITSCT</b>	
<b>Overview</b>	Initialize section
<b>Syntax</b>	INITSCT FUNCTION{}
<b>Description</b>	Initialize DATA and BSS section in accordance with the specified initialization table
<b>Parameters</b>	r0 : Pointer to initialization table for DATA section r1 : Pointer to initialization table for BSS section
<b>Return value</b>	None
<b>R_SC_HardwareSetup</b>	
<b>Overview</b>	Initial setting of peripheral functions
<b>Syntax</b>	void R_SC_HardwareSetup(void)
<b>Description</b>	Initialize peripheral functions This function calls Userdef_PreHardwareSetup function for release locked pin when resuming deep standby mode before doing initialization and calls Userdef_PostHardwareSetup function for enabling write operation in each retention RAM area after doing initialization.
<b>Parameters</b>	None
<b>Return value</b>	None
<b>Note</b>	DATA and BSS section shouldn't be initialized at the time this function is called.

---

**main**

---

**Overview** Main processing**Syntax** `int_t main(void)`**Description** This function displays the information about sample code to the terminal running on the host PC connected with RZ/A2M CPU board via serial interface and initializes GPIO connected to on-board LED.  
Also, OSTM channel 0 is initialized and configured its counter so that the interrupt can be fired every 500ms and then, it is kicked.**Parameters** None**Return value** 0

<hr/> irq_handler <hr/>	
<b>Overview</b>	IRQ handler processing
<b>Syntax</b>	irq_handler
<b>Description</b>	<p>This function is the assembler function executed when the IRQ interrupt is generated. After saving LR_irq, SPSR_irq and general-purpose register to the stack and obtaining the INTC interrupt source ID, calls the INTC_Handler_Interrupt function</p> <p>written in C language and executes the INTC interrupt handler processing which corresponds to the interrupt source ID.</p> <p>After the INTC interrupt handler processing, restores the general-purpose register from the stack, and also restores LR_irq and SPSR_irq from the stack by executing the RFE instruction.</p> <p>When the interrupt ID indicates 1022 and 1023, the interrupt handler processing is omitted.</p> <p>This function executes the processing for saving and restoring and returns to the processing before the interrupt is generated.</p>
<b>Parameters</b>	None
<b>Return value</b>	None
<hr/> INTC_Handler_Interrupt <hr/>	
<b>Overview</b>	INTC interrupt handler processing
<b>Syntax</b>	void INTC_Handler_Interrupt(uint32_t icciar)
<b>Description</b>	<p>This is the INTC interrupt handler processing called by the irq_handler.</p> <p>Executes the handler processing function (function registered in g_intc_func_table [int_id]) corresponding to the interrupt ID specified by icciar.</p> <p>If the interrupt handler function is not registered in g_intc_func_table [int_id], execute the Userdef_INTC_UnregisteredID function.</p> <p>Execute the Userdef_INTC_Pre_Interrupt function and Userdef_INTC_Post_Interrupt function before and after the interrupt handler processing function. If the interrupt ID is 512 or more, execute the Userdef_INTC_Undefld function.</p> <p>If the interrupt handler function is not registered in g_intc_func_table [int_id], execute the Userdef_INTC_UnregisteredID function. Execute the Userdef_INTC_Pre_Interrupt function and Userdef_INTC_Post_Interrupt function before and after the interrupt handler processing function. If the interrupt ID is 512 or more, execute the Userdef_INTC_Undefld function.</p>
<b>Parameters</b>	uint32_t icciar : Interrupt ID (0 to 511)
<b>Return value</b>	None

---

fiq_handler	
<b>Overview</b>	FIQ handler processing
<b>Syntax</b>	fiq_handler
<b>Description</b>	<p>This function is the assembler function executed when the FIQ interrupt is generated. After saving LR_irq, SPSR_irq and general-purpose register to the stack, calls the NMI_Handler_Interrupt function written in C language and executes the NMI handler processing.</p> <p>After the NMI handler processing, restores the general-purpose register from the stack, and also restores LR_irq and SPSR_irq from the stack by executing the RFE instruction. Then returns to the processing before the interrupt was generated from the FIQ interrupt processing.</p>
<b>Parameters</b>	None
<b>Return value</b>	None

---

NMI_Handler_Interrupt	
<b>Overview</b>	NMI interrupt handler processing
<b>Syntax</b>	void NMI_Handler_Interrupt(void)
<b>Description</b>	<p>This is the NMI interrupt handler processing called by the fiq_handler. Executes the handler processing function (registered function in g_intc_func_table[512]) when the interrupt ID is 512.</p> <p>If the interrupt handler function is not registered in g_intc_func_table[512], executes the Userdef_INTC_UnregisteredID function.</p>
<b>Parameters</b>	None
<b>Return value</b>	None

<b>direct_open</b>	
<b>Overview</b>	Open the peripheral I/O driver function
<b>Syntax</b>	int_t direct_open (char_t *p_driver_name, int_t param)
<b>Description</b>	<p>Calls the open function of the peripheral IO driver with the configuration name specified by *p_driver_name. (In other words, calls the Open function related to the peripheral IO driver of the configuration name registered in gs_mount_table.)</p> <p>Close, read, write, and control of the peripheral IO driver functions are performed using the handle number which is the return value of this function. In the sample code, this function is used to open the driver functions of CPG, OSTM0, SCIFA4, and GPIO, and initialize them.</p>
<b>Parameters</b>	char_t *p_driver_name : Configuration name int_t param : Open attribute
<b>Return value</b>	0 or more : Success -1 : Error
<b>direct_close</b>	
<b>Overview</b>	Close the peripheral I/O driver function
<b>Syntax</b>	int_t direct_close (int_t handle)
<b>Description</b>	<p>Calls the close function of the peripheral IO driver function with the handle number. In the sample code, the driver functions of OSTM0 and SCIFA4 are closed.</p>
<b>Parameters</b>	int_t handle : Handle number
<b>Return value</b>	0 or more : Success -1 : Error
<b>direct_read</b>	
<b>Overview</b>	Read the peripheral I/O driver function
<b>Syntax</b>	int_t direct_read (int handle, uint8_t *buff_ptr, uint32_t count)
<b>Description</b>	<p>Calls the read function of the peripheral IO driver function with the handle number. When calling the read function, pass the pointer of the read data storage buffer specified by *buff_ptr and the number of bytes of the data to be read specified by count. The sample code calls the read function of OSTM0 and SCIFA4.</p>
<b>Parameters</b>	int handle : Handle number uint8_t *buff_ptr : Pointer of read data storage buffer uint32_t count : Number of bytes of read data
<b>Return value</b>	0 or more : Number of bytes of read data -1 : Error



<b>direct_write</b>	
<b>Overview</b>	Write the peripheral I/O driver function
<b>Syntax</b>	<code>int_t direct_write (int handle, uint8_t *buff_ptr, uint32_t count)</code>
<b>Description</b>	<p>Calls the write function of the peripheral IO driver function with the handle number. When calling the write function, pass the pointer of the write data storage buffer that specified by <code>*buff_ptr</code> and the number of bytes of the data to be write that specified by <code>count</code>.</p> <p>The sample code calls the write function of SCIFA4.</p>
<b>Parameters</b>	<p><code>int handle</code> : Handle number</p> <p><code>uint8_t *buff_ptr</code> : Pointer of write data storage buffer</p> <p><code>uint32_t count</code> : Number of bytes of write data</p>
<b>Return value</b>	<p>0 or more : Number of bytes of write data</p> <p>-1 : Error</p>
<b>direct_control</b>	
<b>Overview</b>	Control the peripheral I/O driver function
<b>Syntax</b>	<code>int_t direct_control (int handle, uint32_t ctrlCode, void *pCtrlStruct)</code>
<b>Description</b>	<p>Calls the control function of the peripheral IO driver function with the handle number. When calling the control function, pass the control code that specified by <code>ctrlCode</code> and the pointer of a structure related to the control code that specified by <code>*pCtrlStruct</code>.</p> <p>The sample code calls the control function of "Start counting of OSTM0 timer" and "GPIO setting of LED connection port".</p>
<b>Parameters</b>	<p><code>int handle</code> : Handle number</p> <p><code>uint32_t ctrlCode</code> : Control code</p> <p><code>void *pCtrlStruct</code> : Pointer of a structure related to the control code</p>
<b>Return value</b>	<p>0 or more : Success</p> <p>-1 : Error</p>
<b>direct_get_version</b>	
<b>Overview</b>	Get version information of the peripheral I/O driver
<b>Syntax</b>	<code>int_t direct_get_version(char *p_driver_name, st_ver_info_t *info)</code>
<b>Description</b>	This function returns the version information of the peripheral IO driver corresponding to the configuration name specified by the argument <code>*p_driver_name</code> .
<b>Parameters</b>	<p><code>char_t *p_driver_name</code> : Configuration name</p> <p><code>st_ver_info_t *info</code> : Pointer to the variable that stores the version information</p>
<b>Return value</b>	<p>0 or more : Success</p> <p>-1 : Error</p>

<b>Sample_LED_Blink</b>	
<b>Overview</b>	OSTM channel 0 interrupt processing
<b>Syntax</b>	void Sample_LED_Blink (uint32_t int_sense)
<b>Description</b>	This function is executed when the OSTM0 interrupt is accepted. In this sample code, this function executes the processing to blink the LEDs on the RZ/A2M CPU board every 500ms.
<b>Parameters</b>	uint32_t int_sense : Detection method for interrupts INTC_LEVEL_SENSITIVE : Level sense INTC_EDGE_TRIGGER : Edge trigger
<b>Return value</b>	None
<b>r_disable_rtc</b>	
<b>Overview</b>	Setting process of unused channel of RTC
<b>Syntax</b>	static void r_disable_rtc (uint32_t ch)
<b>Description</b>	Perform processing for setting the unused channel of RTC described in "Figure 5.11 Processing Flow for RTC Unused".
<b>Parameters</b>	uint32_t ch : RTC channel number (0 or 1)
<b>Return value</b>	None
<b>r_disable_usb</b>	
<b>Overview</b>	Setting process of unused channel of USB
<b>Syntax</b>	static void r_disable_usb (uint32_t ch)
<b>Description</b>	Perform processing for setting the unused channel of RTC described in "Figure 5.12 Processing Flow for USB Unused".
<b>Parameters</b>	uint32_t ch : USB channel number (0 or 1)
<b>Return value</b>	None



---

**R\_MMU\_VAtoPA**

---

<b>Overview</b>	Translate virtual address to physical address
<b>Syntax</b>	Translate virtual address specified by argument to physical address.
<b>Description</b>	e_mmu_err_t R_MMU_VAtoPA ( uint32_t vaddress, uint32_t *paddress )
<b>Parameters</b>	uint32_t vaddress : virtual address uint32_t *paddress : storage area of physical address
<b>Return value</b>	MMU_SUCCESS : Success MMU_ERR_TRANSLATION : Translation Error
<b>Notes</b>	This function must be invoked after R_MMU_Init is terminated

---

<b>R_CACHE_L1Init</b>	
<b>Overview</b>	Initialization of the L1 cache
<b>Syntax</b>	void R_CACHE_L1Init(void)
<b>Description</b>	In this sample code, the L1 cache, program flow predictor, and L1 prefetcher are set to enabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1InstEnable</b>	
<b>Overview</b>	Setting the L1 instruction cache to enabled
<b>Syntax</b>	void R_CACHE_L1InstEnable(void)
<b>Description</b>	Sets the L1 instruction cache to enabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1InstDisable</b>	
<b>Overview</b>	Setting the L1 instruction cache to disabled
<b>Syntax</b>	void R_CACHE_L1InstDisable(void)
<b>Description</b>	Sets the L1 instruction cache to disabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1InstInvalidAll</b>	
<b>Overview</b>	Invalidate all L1 instruction cache lines
<b>Syntax</b>	void R_CACHE_L1InstInvalidAll(void)
<b>Description</b>	This function performs invalidate operation to all cache lines of the L1 instruction cache.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1DataEnable</b>	
<b>Overview</b>	Setting the L1 data cache to enabled
<b>Syntax</b>	void R_CACHE_L1DataEnable(void)
<b>Description</b>	Sets the L1 data cache to enabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1DataDisable</b>	
<b>Overview</b>	Setting the L1 data cache to disabled
<b>Syntax</b>	void R_CACHE_L1DataDisable(void)
<b>Description</b>	Sets the L1 data cache to disabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1DataInvalidAll</b>	
<b>Overview</b>	Invalidate all L1 data cache lines
<b>Syntax</b>	void R_CACHE_L1DataInvalidAll(void)
<b>Description</b>	This function performs invalidate operation to all cache lines of the L1 data cache.
<b>Parameters</b>	None
<b>Return value</b>	None
<b>R_CACHE_L1DataCleanAll</b>	
<b>Overview</b>	Clean all L1 data cache lines
<b>Syntax</b>	void R_CACHE_L1DataCleanAll(void)
<b>Description</b>	This function performs clean operation to all cache lines of the L1 data cache.
<b>Parameters</b>	None
<b>Return value</b>	None
<b>R_CACHE_L1DataCleanInvalidAll</b>	
<b>Overview</b>	Clean&Invalidate all L1 data cache lines
<b>Syntax</b>	void R_CACHE_L1DataCleanInvalidAll(void)
<b>Description</b>	This function performs combination of clean and invalidate operations to all cache lines of the L1 data cache.
<b>Parameters</b>	None
<b>Return value</b>	None
<b>R_CACHE_L1DataInvalidLine</b>	
<b>Overview</b>	Invalidate L1 data cache on cache lines (32 byte) basis
<b>Syntax</b>	e_err_code_t R_CACHE_L1DataInvalidLine(void* line_addr, uint32_t size)
<b>Description</b>	Invalidate the L1 data cache of each cache line from the address that specified by in_addr to the region they specified by size.
<b>Parameters</b>	void* line_addr : Start address of invalidate operation target region uint32_t size : Number of bytes to invalidate
<b>Return value</b>	DRV_SUCCESS : Success DRV_ERROR: Error
<b>R_CACHE_L1DataCleanLine</b>	
<b>Overview</b>	Clean L1 data cache on cache lines (32 byte) basis
<b>Syntax</b>	e_err_code_t R_CACHE_L1DataCleanLine(void* line_addr, uint32_t size)
<b>Description</b>	Clean the L1 data cache of each cache line from the address that specified by in_addr to the region they specified by size.
<b>Parameters</b>	void* line_addr : Start address of clean operation target region uint32_t size : Number of bytes to clean
<b>Return value</b>	DRV_SUCCESS: Success DRV_ERROR: Error

---

<b>R_CACHE_L1DataCleanInvalidLine</b>	
<b>Overview</b>	Clean&Invalidate L1 data cache on cache lines (32 byte) basis
<b>Syntax</b>	e_err_code_t R_CACHE_L1DataCleanInvalidLine(void* line_addr, uint32_t size)
<b>Description</b>	Clean&Invalidate the L1 data cache of each cache line from the address that specified by in_addr to the region they specified by size.
<b>Parameters</b>	void* line_addr : Start address of clean&invalidate operation target region uint32_t size : Number of bytes to clean&invalidate
<b>Return value</b>	DRV_SUCCESS: Success DRV_ERROR: Error

---

<b>R_CACHE_L1BtacEnable</b>	
<b>Overview</b>	Setting the program predictor to enabled
<b>Syntax</b>	void R_CACHE_L1BtacEnable(void)
<b>Description</b>	Sets the program flow predictor to enabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1BtacDisable</b>	
<b>Overview</b>	Setting the program flow predictor to disabled
<b>Syntax</b>	void R_CACHE_L1BtacDisable(void)
<b>Description</b>	Sets the program flow predictor to disabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

<b>R_CACHE_L1BtacInvalidate</b>	
<b>Overview</b>	Invalidate all entries of the program flow predictor.
<b>Syntax</b>	void R_CACHE_L1BtacInvalidate(void)
<b>Description</b>	This function performs invalidate operation to all entries of the program flow predictor.
<b>Parameters</b>	None
<b>Return value</b>	None

---

---

**R\_CACHE\_L1PrefetchEnable**

---

<b>Overview</b>	Setting the L1 prefetcher to enabled
<b>Syntax</b>	void R_CACHE_L1PrefetchEnable(void)
<b>Description</b>	Sets the L1 prefetcher to enabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

**R\_CACHE\_L1PrefetchDisable**

---

<b>Overview</b>	Setting the L1 prefetcher to disabled
<b>Syntax</b>	void R_CACHE_L1PrefetchDisable(void)
<b>Description</b>	Sets the L1 prefetcher to disabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

**R\_CACHE\_L2Init**

---

<b>Overview</b>	Initialization of the L2 cache
<b>Syntax</b>	void R_CACHE_L2Init(void)
<b>Description</b>	This function initializes the L2 cache in the following procedure. <ol style="list-style-type: none"><li>1. Sets the L2 cache to disabled.</li><li>2. Invalidate all L2 cache lines.</li><li>3. Clear the all interrupt status of the L2 cache.</li><li>4. Sets the L2 cache to enabled.</li></ol>
<b>Parameters</b>	None
<b>Return value</b>	None



---

**R\_CACHE\_L2CacheEnable**

---

<b>Overview</b>	Setting the L2 cache to enabled
<b>Syntax</b>	void R_CACHE_L2CacheEnable(void)
<b>Description</b>	Sets the L2 cache to enabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

**R\_CACHE\_L2\_CacheDisable**

---

<b>Overview</b>	Setting the L2 cache to disabled
<b>Syntax</b>	void R_CACHE_L2CacheDisable(void)
<b>Description</b>	Sets the L2 cache to disabled.
<b>Parameters</b>	None
<b>Return value</b>	None

---

**R\_CACHE\_L2InvalidAll**

---

<b>Overview</b>	Invalidate all L2 caches
<b>Syntax</b>	void R_CACHE_L2InvalidAll(void)
<b>Description</b>	In this sample code, all L2 cache lines are invalidated by way-based operation.
<b>Parameters</b>	None
<b>Return value</b>	None

---

**R\_CACHE\_L2CleanAll**

---

<b>Overview</b>	Clean all L2 cache
<b>Syntax</b>	void R_CACHE_L2CleanAll(void)
<b>Description</b>	In this sample code, all L2 cache lines are cleaned by way-based operation.
<b>Parameters</b>	None
<b>Return value</b>	None

---

**R\_CACHE\_L2CleanInvalidAll**

---

<b>Overview</b>	Clean&Invalidate all L2 cache
<b>Syntax</b>	void R_CACHE_L2CleanInvalidAll(void)
<b>Description</b>	In this sample code, all L2 cache lines are clean&invalidated by way-based operation.
<b>Parameters</b>	None
<b>Return value</b>	None

<b>R_INTC_Init</b>	
<b>Overview</b>	Initialization of INTC
<b>Syntax</b>	<code>e_r_drv_intc_err_t R_INTC_Init(void)</code>
<b>Description</b>	Initialize the GIC interrupt controller. The interrupts with the interrupt priority level from 0 to 30 are accepted.
<b>Parameters</b>	None
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success
<b>R_INTC_Enable</b>	
<b>Overview</b>	INTC interrupt enable
<b>Syntax</b>	<code>e_r_drv_intc_err_t R_INTC_Enable(e_r_drv_intc_intid_t int_id)</code>
<b>Description</b>	Enables the interrupts of the ID specified by the <code>int_id</code> .
<b>Parameters</b>	<code>e_r_drv_intc_intid_t int_id</code> : Interrupt ID (0 to 511)
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success <code>INTC_ERR_INVALID_ID</code> : Invalid interrupt ID
<b>R_INTC_Disable</b>	
<b>Overview</b>	INTC interrupt disable
<b>Syntax</b>	<code>e_r_drv_intc_err_t R_INTC_Disable(e_r_drv_intc_intid_t int_id)</code>
<b>Description</b>	Disables the interrupts of the ID specified by the <code>int_id</code> .
<b>Parameters</b>	<code>e_r_drv_intc_intid_t int_id</code> : Interrupt ID (0 to 511)
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success <code>INTC_ERR_INVALID_ID</code> : Invalid interrupt ID
<b>R_INTC_SetPriority</b>	
<b>Overview</b>	Setting for INTC interrupt priority level
<b>Syntax</b>	<code>e_r_drv_intc_err_t R_INTC_SetPriority(e_r_drv_intc_intid_t int_id, intc_priority_t priority)</code>
<b>Description</b>	Sets the interrupt priority level for the ID specified by the <code>int_id</code> to the priority level specified by the <code>priority</code> .
<b>Parameters</b>	<code>e_r_drv_intc_intid_t int_id</code> : Interrupt ID (0 to 511) <code>intc_priority_t priority</code> : Interrupt priority level (0 to 31 (0 : Highest level, 31 : Lowest level ))
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success <code>INTC_ERR_INVALID_ID</code> : Invalid interrupt ID <code>INTC_ERR_INVALID_PRIORITY</code> : Invalid interrupt priority level
<b>Notes</b>	If 31 ( <code>INTC_PRIORITY_LOWEST</code> or <code>INTC_PRIORITY_31</code> ) is specified as the interrupt priority level for this function, no interrupt is generated for the specified ID.

<b>R_INTC_SetMaskLevel</b>	
<b>Overview</b>	Setting for INTC interrupt mask level
<b>Syntax</b>	<code>e_r_drv_intc_err_t R_INTC_SetMaskLevel(e_r_drv_intc_priority_t mask_level)</code>
<b>Description</b>	Sets the interrupt mask level specified by the <code>mask_level</code> .
<b>Parameters</b>	<code>e_r_drv_intc_priority_t</code> : Interrupt priority mask level (0 to 31 (0 : Highest level, 31 : Lowest level ))
<b>Return value</b>	INTC_SUCCESS : Success INTC_ERR_INVALID_PRIORITY : Invalid interrupt priority mask level
<b>Notes</b>	Masks the generation of an interrupt whose priority level is lower than the mask level specified for this function. (Interrupts are masked if the priority level values are equal or higher)
<b>R_INTC_GetMaskLevel</b>	
<b>Overview</b>	Obtaining INTC interrupt mask level
<b>Syntax</b>	<code>e_r_drv_intc_err_t R_INTC_GetMaskLevel(e_r_drv_intc_priority_t *mask_level)</code>
<b>Description</b>	Obtains the setting value of the interrupt mask level and returns the obtained value to the <code>mask_level</code> .
<b>Parameters</b>	<code>e_r_drv_intc_priority_t</code> : Pointer to the variable that stores the interrupt mask level (0 to 31 (0 : Highest level, 31 : Lowest level ))
<b>Return value</b>	INTC_SUCCESS : Success
<b>R_INTC_RegistIntFunc</b>	
<b>Overview</b>	Registration of INTC interrupt handler function
<b>Syntax</b>	<code>e_r_drv_intc_err_t R_INTC_RegistIntFunc(e_r_drv_intc_intid_t int_id, void (*func)(uint32_t int_sense))</code>
<b>Description</b>	Register the function specified by <code>func</code> in the interrupt handler function table as the component specified by <code>int_id</code> . (Interrupt handler is registered to <code>g_intc_func_table[int_id]</code> by this function) When 512 is specified as <code>int_id</code> , this function registers the handler of NMI. (NMI handler is also registered to <code>g_intc_func_table[int_id]</code> by this function) If an invalid interrupt ID outside the range is specified, this function does not register an interrupt handler.
<b>Parameters</b>	<code>e_r_drv_intc_intid_t</code> : Interrupt ID (0 to 512) <code>int_id</code> <code>void (* func)</code> : Pointer to interrupt handler function (A function with " <code>uint32_t int_sense</code> " as an argument is required) <code>(uint32_t int_sense)</code>
<b>Return value</b>	INTC_SUCCESS : Success INTC_ERR_INVALID : Error

---

**R\_STB\_StartModule**

---

<b>Overview</b>	Canceling Module Standby
<b>Syntax</b>	int_t R_STB_StartModule(e_stb_module_t module)
<b>Description</b>	Cancels the module standby state of the module specified by the argument "module". By calling this function, clock is supplied to the specified module.
<b>Parameters</b>	e_stb_module_t module : Number of the module
<b>Return value</b>	DRV_SUCCESS : Success DRV_ERROR : Error

---

**R\_STB\_StopModule**

---

<b>Overview</b>	Transition to Module Standby
<b>Syntax</b>	int_t R_STB_StopModule(e_stb_module_t module)
<b>Description</b>	Transitions the module that specified by the argument "module" to the module standby state. By calling this function, halts clock supply to the specified module.
<b>Parameters</b>	e_stb_module_t module : Number of the module
<b>Return value</b>	DRV_SUCCESS : Success DRV_ERROR : Error

<b>R_CPG_InitialiseHwlf</b>	
<b>Overview</b>	Initialization process of CPG
<b>Syntax</b>	<code>int_t R_CPG_InitialiseHwlf( void )</code>
<b>Description</b>	<p>This function sets CPG registers (FRQCR, CKIOSEL, SCLKSEL) by using CPG configuration data of <code>r_cpg_drv_sc_cfg.h</code>.</p> <p>In the sample code, this function is called via the <code>direct_open</code> function and becomes the operating frequency described in "Table 2.1 Operation Conformation Condition (1/2)".</p>
<b>Parameters</b>	None
<b>Return value</b>	<p><code>DRV_SUCCESS</code> : Success</p> <p><code>DRV_ERROR</code> : CPG configuration data of <code>r_cpg_drv_sc_cfg.h</code> is invalid.</p>
<b>R_GPIO_HWInitialise</b>	
<b>Overview</b>	Initialization process of GPIO
<b>Syntax</b>	<code>int_t R_GPIO_HWInitialise(void)</code>
<b>Description</b>	<p>Initialize the GPIO driver. Also, after initializing the GPIO driver, this function refers to the data of <code>GPIO_SC_TABLE_INIT[]</code> in <code>r_gpio_drv_sc_cfg.h</code> and execute the pin setting processing.</p> <p>In the sample code, this function is called by the <code>direct_open</code> function when opening the GPIO driver function, but since the element of <code>GPIO_SC_TABLE_INIT[]</code> is not defined, the setting processing of the pins by this function is not performed.</p>
<b>Parameters</b>	None
<b>Return value</b>	<code>DRV_SUCCESS</code> : Success
<b>Notes</b>	<p>The GPIO driver manages the pin to which the pin function is assigned by this function as "in use" state.</p> <p>In the GPIO driver, pins that are managed as "in use" state can not be reset to other pin functions. To reconfigure the pin function, set the pin to "unused" state by using the <code>R_GPIO_ClearByPinList</code> function beforehand.</p>
<b>R_GPIO_InitByPinList</b>	
<b>Overview</b>	GPIO setting by pin list
<b>Syntax</b>	<code>e_r_drv_gpio_err_t R_GPIO_PinInitByPinList(const r_gpio_port_pin_t * p_pin_list, uint32_t count)</code>
<b>Description</b>	<p>Configure GPIO with pin list.</p> <p>In the sample code, this function is called by the <code>direct_control</code> function, and P6_0 is set to be able to turn on and off the LED on the RZ/A2M CPU board.</p>
<b>Parameters</b>	<p><code>const r_gpio_port_pin_t *</code> : Pointer of pin list</p> <p><code>p_pin_list</code></p> <p><code>uint32_t count</code> : Number of pin to set</p>
<b>Return value</b>	<p><code>GPIO_SUCCESS</code> : Success</p> <p>Other than <code>GPIO_SUCCESS</code> : Error</p>
<b>Notes</b>	<p>The GPIO driver manages the pin to which the pin function is assigned by this function as "in use" state.</p> <p>In the GPIO driver, pins that are managed as "in use" state can not be reset to other pin functions. To reconfigure the pin function, set the pin to "unused" state by using the <code>R_GPIO_ClearByPinList</code> function beforehand.</p>

R_GPIO_InitByTable	
<b>Overview</b>	GPIO setting by GPIO configuration table
<b>Syntax</b>	<code>e_r_drv_gpio_err_t R_GPIO_PinInitByTable(const st_r_drv_gpio_sc_config_t * p_table, uint32_t count)</code>
<b>Description</b>	Specify GPIO configuration table with argument <code>p_table</code> and perform pin setting processing. In the sample code, the this function is called when opening the SCIFA driver, and the P9_0 and P9_1 pins are set to TxD4 and RxD4 functions for SCIFA.
<b>Parameters</b>	<code>const</code> : Pointer of GPIO configuration table <code>st_r_drv_gpio_sc_config_t * p_table</code>
<b>Return value</b>	<code>uint32_t count</code> : Number of pins to set <code>GPIO_SUCCESS</code> : Success Other than <code>GPIO_SUCCESS</code> : Error
<b>Notes</b>	The GPIO driver manages the pin to which the pin function is assigned by this function as "in use" state. In the GPIO driver, pins that are managed as "in use" state can not be reset to other pin functions. To reconfigure the pin function, set the pin to "unused" state by using the <code>R_GPIO_ClearByPinList</code> function beforehand.
R_GPIO_PinWrite	
<b>Overview</b>	Setting the pin output level
<b>Syntax</b>	<code>e_r_drv_gpio_err_t R_GPIO_PinWrite(e_r_drv_gpio_pin_t pin, e_r_drv_gpio_level_t level)</code>
<b>Description</b>	When the pin specified by the argument "pin" is set to general I/O(OUTPUT), set the output level of the pin specified by "pin" to the value specified by "level".
<b>Parameters</b>	<code>e_r_drv_gpio_pin_t pin</code> : Pin number <code>e_r_drv_gpio_level_t level</code> : Output level GPIO_LEVEL_LOW : 1 GPIO_LEVEL_HIGH : 2
<b>Return value</b>	<code>GPIO_SUCCESS</code> : Success Other than <code>GPIO_SUCCESS</code> : Error
R_GPIO_PinRead	
<b>Overview</b>	Getting the pin input level
<b>Syntax</b>	<code>e_r_drv_gpio_err_t R_GPIO_PinRead(e_r_drv_gpio_pin_t pin, e_r_drv_gpio_level_t *p_level)</code>
<b>Description</b>	When the pin specified by the argument "pin" is set to general I/O(INPUT), acquires the input level of the pin specified as "pin" and stores it in <code>p_level</code> .
<b>Parameters</b>	<code>e_r_drv_gpio_pin_t pin</code> : Pin number <code>e_r_drv_gpio_level_t *p_level</code> : Pointer of structure that stores input level GPIO_LEVEL_LOW : 1 GPIO_LEVEL_HIGH : 2
<b>Return value</b>	<code>GPIO_SUCCESS</code> : Success Other than <code>GPIO_SUCCESS</code> : Error

RZA_IO_RegWrite_8	
<b>Overview</b>	I/O register write function (For I/O register accessible by 8 bits)
<b>Syntax</b>	void RZA_IO_RegWrite_8(volatile uint8_t * ioreg, uint8_t write_value, uint8_t shift, uint32_t mask)
<b>Description</b>	Executes write processing for the on-chip peripheral I/O register which can be accessed by 8 bits.
<b>Parameters</b>	<div>volatile uint8_t *ioreg : I/O register to be written The I/O register defined in the directory under the iodefines should be specified.</div> <div>uint8_t write_value : Write value to the I/O register</div> <div>uint8_t shift : Left shift value to the bit for I/O register Defines the value to access to the bit position within the I/O register as a shift value in the directory under the iobitmasks. The shift value to the defined I/O register should be specified.</div> <div>uint32_t mask : Mask value of the bit for I/O register Defines the value to access to the bit position within the I/O register as a mask value in the directory under the iobitmasks. The mask value of the defined I/O register should be specified. When "IOREG_NONMASK_ACCESS" is specified, write to the I/O register directly without performing mask processing (read-modify-write processing).</div>
<b>Return value</b>	None
<b>Notes</b>	When transferring this function to the RAM area, do not call this function before the section is transferred from the ROM area to the RAM area.

RZA_IO_RegWrite_16	
<b>Overview</b>	I/O register write function (For I/O register accessible by 16 bits)
<b>Syntax</b>	void RZA_IO_RegWrite_16(volatile uint16_t * ioreg, uint16_t write_value, uint16_t shift, uint32_t mask)
<b>Description</b>	Executes write processing for the on-chip peripheral I/O register which can be accessed by 16 bits.
<b>Parameters</b>	<div>volatile uint16_t *ioreg : I/O register to be written The I/O register defined in the directory under the iodefines should be specified.</div> <div>uint16_t write_value : Write value to the I/O register</div> <div>uint16_t shift : Left shift value to the bit for I/O register Defines the value to access to the bit position within the I/O register as a shift value in the directory under the iobitmasks. The shift value to the defined I/O register should be specified.</div> <div>uint32_t mask : Mask value of the bit for I/O register Defines the value to access to the bit position within the I/O register as a mask value in the directory under the iobitmasks. The mask value of the defined I/O register should be specified. When "IOREG_NONMASK_ACCESS" is specified, write to the I/O register directly without performing mask processing (read-modify-write processing).</div>
<b>Return value</b>	None
<b>Notes</b>	When transferring this function to the RAM area, do not call this function before the section is transferred from the ROM area to the RAM area.



RZA_IO_RegWrite_32	
<b>Overview</b>	I/O register write function (For I/O register accessible by 32 bits)
<b>Syntax</b>	void RZA_IO_RegWrite_32(volatile uint32_t * ioreg, uint32_t write_value, uint32_t shift, uint32_t mask)
<b>Description</b>	Executes write processing for the on-chip peripheral I/O register which can be accessed by 32 bits.
<b>Parameters</b>	<div>volatile uint32_t *ioreg : I/O register to be written The I/O register defined in the directory under the iodefines should be specified.</div> <div>uint32_t write_value : Write value to the I/O register</div> <div>uint32_t shift : Left shift value to the bit for I/O register Defines the value to access to the bit position within the I/O register as a shift value in the directory under the iobitmasks. The shift value to the defined I/O register should be specified.</div> <div>uint32_t mask : Mask value of the bit for I/O register Defines the value to access to the bit position within the I/O register as a mask value in the directory under the iobitmasks. The mask value of the defined I/O register should be specified. When "IOREG_NONMASK_ACCESS" is specified, write to the I/O register directly without performing mask processing (read-modify-write processing).</div>
<b>Return value</b>	None
<b>Notes</b>	When transferring this function to the RAM area, do not call this function before the section is transferred from the ROM area to the RAM area.

RZA_IO_RegRead_8	
<b>Overview</b>	I/O register read function (For I/O register accessible by 8 bits)
<b>Syntax</b>	uint8_t RZA_IO_RegRead_8(volatile uint8_t * ioreg, uint8_t shift, uint32_t mask)
<b>Description</b>	Executes read processing for the on-chip peripheral I/O register which can be accessed by 8 bits.
<b>Parameters</b>	<div>volatile uint8_t *ioreg : I/O register to be read</div> <div>The I/O register defined in the directory under the iodefines should be specified.</div> <div>uint8_t shift : Left shift value to the bit for I/O register</div> <div>Defines the value to access to the bit position within the I/O register as a shift value in the directory under the iobitmasks. The shift value to the defined I/O register should be specified.</div> <div>uint32_t mask : Mask value of the bit for I/O register</div> <div>Defines the value to access to the bit position within the I/O register as a mask value in the directory under the iobitmasks. The mask value of the defined I/O register should be specified. When "IOREG_NONMASK_ACCESS" is specified, the I/O register is directly read without mask processing.</div>
<b>Return value</b>	Read value of the specified I/O register
<b>Notes</b>	When transferring this function to the RAM area, do not call this function before the section is transferred from the ROM area to the RAM area.

RZA_IO_RegRead_16	
<b>Overview</b>	I/O register read function (For I/O register accessible by 16 bits)
<b>Syntax</b>	uint16_t RZA_IO_RegRead_16(volatile uint16_t * ioreg, uint16_t shift, uint32_t mask)
<b>Description</b>	Executes read processing for the on-chip peripheral I/O register which can be accessed by 16 bits.
<b>Parameters</b>	<div>volatile uint16_t *ioreg : I/O register to be read The I/O register defined in the directory under the iodefines should be specified.</div> <div>uint16_t shift : Left shift value to the bit for I/O register Defines the value to access to the bit position within the I/O register as a shift value in the directory under the iobitmasks. The shift value to the defined I/O register should be specified.</div> <div>uint32_t mask : Mask value of the bit for I/O register Defines the value to access to the bit position within the I/O register as a mask value in the directory under the iobitmasks. The mask value of the defined I/O register should be specified. When "IOREG_NONMASK_ACCESS" is specified, the I/O register is directly read without mask processing.</div>
<b>Return value</b>	Read value of the specified I/O register
<b>Notes</b>	When transferring this function to the RAM area, do not call this function before the section is transferred from the ROM area to the RAM area.

RZA_IO_RegRead_32	
<b>Overview</b>	I/O register read function (For I/O register accessible by 32 bits)
<b>Syntax</b>	uint32_t RZA_IO_RegRead_32(volatile uint32_t * ioreg, uint32_t shift, uint32_t mask)
<b>Description</b>	Executes read processing for the on-chip peripheral I/O register which can be accessed by 32 bits.
<b>Parameters</b>	<div>volatile uint32_t *ioreg : I/O register to be read The I/O register defined in the directory under the iodefines should be specified.</div> <div>uint32_t shift : Left shift value to the bit for I/O register Defines the value to access to the bit position within the I/O register as a shift value in the directory under the iobitmasks. The shift value to the defined I/O register should be specified.</div> <div>uint32_t mask : Mask value of the bit for I/O register Defines the value to access to the bit position within the I/O register as a mask value in the directory under the iobitmasks. The mask value of the defined I/O register should be specified. When "IOREG_NONMASK_ACCESS" is specified, the I/O register is directly read without mask processing.</div>
<b>Return value</b>	Read value of the specified I/O register
<b>Notes</b>	When transferring this function to the RAM area, do not call this function before the section is transferred from the ROM area to the RAM area.

<b>Userdef_INTC_Pre_Interrupt</b>	
<b>Overview</b>	Callback function that before interrupt handler processing is executed
<b>Syntax</b>	<code>e_r_drv_intc_err_t Userdef_INTC_Pre_Interrupt(e_r_drv_intc_intid_t int_id)</code>
<b>Description</b>	This is the user-defined function called by the <code>INTC_Handler_Interrupt</code> . Implement the necessary processing before calling each interrupt handler. In the sample code implementation, this function returns without doing anything.
<b>Parameters</b>	<code>e_r_drv_intc_intid_t</code> : Interrupt ID (0 to 511) <code>int_id</code>
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success
<b>Userdef_INTC_Post_Interrupt</b>	
<b>Overview</b>	Callback function that after interrupt handler processing is executed
<b>Syntax</b>	<code>e_r_drv_intc_err_t Userdef_INTC_Post_Interrupt(e_r_drv_intc_intid_t int_id)</code>
<b>Description</b>	This is the user-defined function called by the <code>INTC_Handler_Interrupt</code> . Implement the necessary processing after returning from each interrupt handler. In the sample code implementation, this function returns without doing anything.
<b>Parameters</b>	<code>e_r_drv_intc_intid_t</code> : Interrupt ID (0 to 511) <code>int_id</code>
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success
<b>Userdef_INTC_UndefId</b>	
<b>Overview</b>	Processing when accepting unsupported interrupt ID of INTC interrupt
<b>Syntax</b>	<code>e_r_drv_intc_err_t Userdef_INTC_UndefId(e_r_drv_intc_intid_t int_id)</code>
<b>Description</b>	This is the user-defined function called by the <code>INTC_Handler_Interrupt</code> . Implement the function to be executed when the interrupts which have unsupported interrupt IDs with 512 and above are accepted.
<b>Parameters</b>	<code>e_r_drv_intc_intid_t</code> : Interrupt ID (512 to 1021) <code>int_id</code>
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success
<b>Userdef_INTC_UnregisteredID</b>	
<b>Overview</b>	Processing when INTC interrupt handler accepts unregistered ID
<b>Syntax</b>	<code>e_r_drv_intc_err_t Userdef_INTC_UnregisteredID(e_r_drv_intc_intid_t int_id)</code>
<b>Description</b>	This is the user-defined function called by the <code>INTC_Handler_Interrupt</code> . Implement the function to be executed when the interrupt ID with an unregistered user interrupt handler function is accepted. This sample code disables the IRQ interrupt and executes the processing for infinite loop.
<b>Parameters</b>	<code>e_r_drv_intc_intid_t</code> : Interrupt ID (0 to 511) <code>int_id</code>
<b>Return value</b>	<code>INTC_SUCCESS</code> : Success

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<b>Userdef_PreHardwareSetup</b>	
<b>Overview</b>	Processing to be performed before executing hardware initialization
<b>Syntax</b>	void Userdef_PreHardwareSetup (void)
<b>Description</b>	This is user-defined function for implementing additional process before executing hardware initialization and called in beginning of R_SC_HardwareSetup function. In application program, clear IOKEEP bit to release retain of pin states after canceling deep standby mode.
<b>Parameters</b>	None
<b>Return value</b>	None

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<b>Userdef_PostHardwareSetup</b>	
<b>Overview</b>	Processing to be performed after executing hardware initialization
<b>Syntax</b>	void Userdef_PostHardwareSetup (void)
<b>Description</b>	This is user-defined function for implementing additional process before executing hardware initialization and called in end of R_SC_HardwareSetup function. In application program, enables writing to page in each on-chip data-retention RAM.
<b>Parameters</b>	None
<b>Return value</b>	None

---

## 5.8 Flowcharts

### 5.8.1 Reset Handler Processing

Figure 5.13 shows the flowchart of Reset Handler Processing.

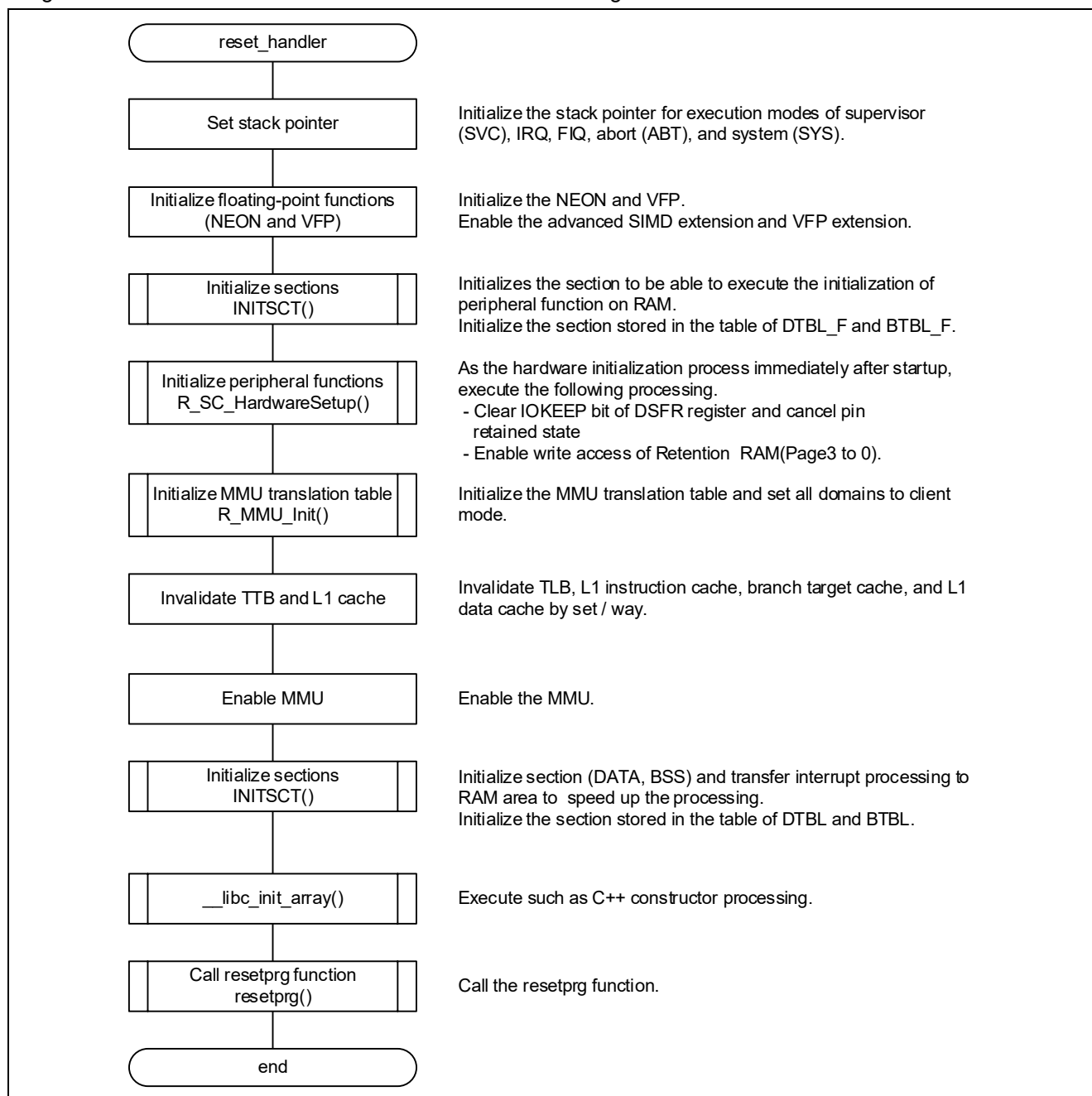


Figure 5.13 Reset Handler Processing

### 5.8.2 resetprg Function

Figure 5.14 shows the flowchart of resetprg Function.

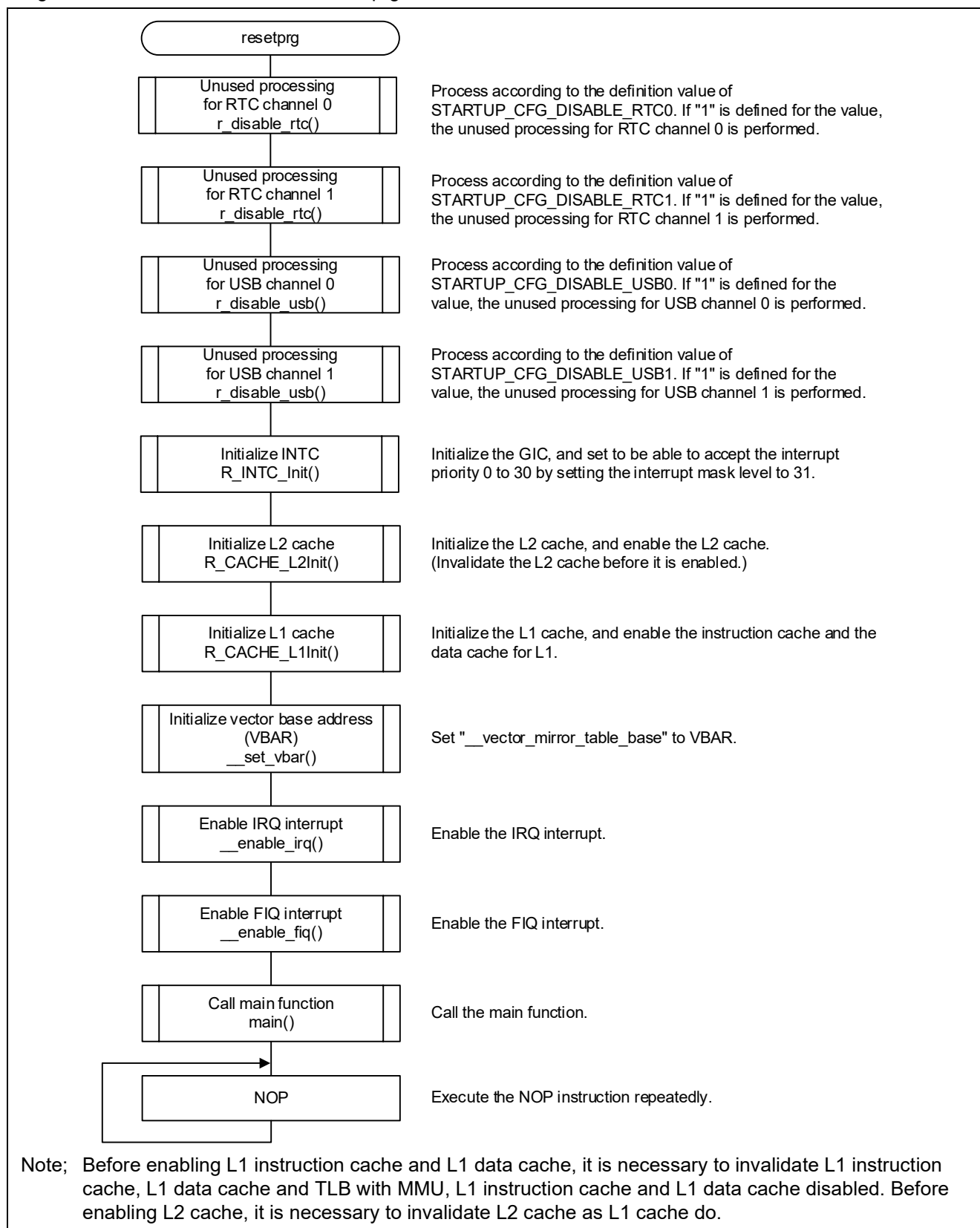


Figure 5.14 resetprg Function



### 5.8.3 Main Processing

Figure 5.15 and Figure 5.16 show the flowchart of Main Processing.

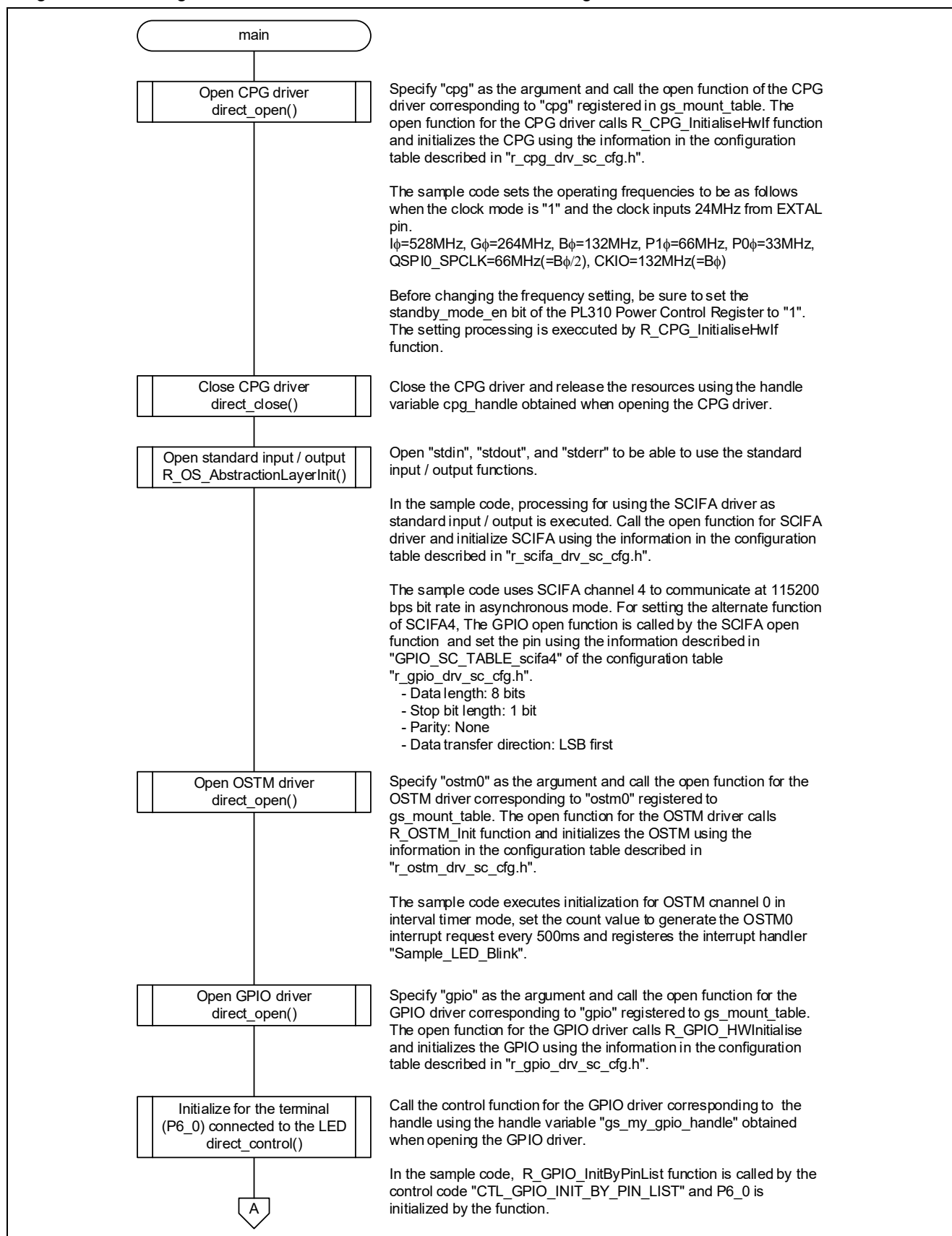
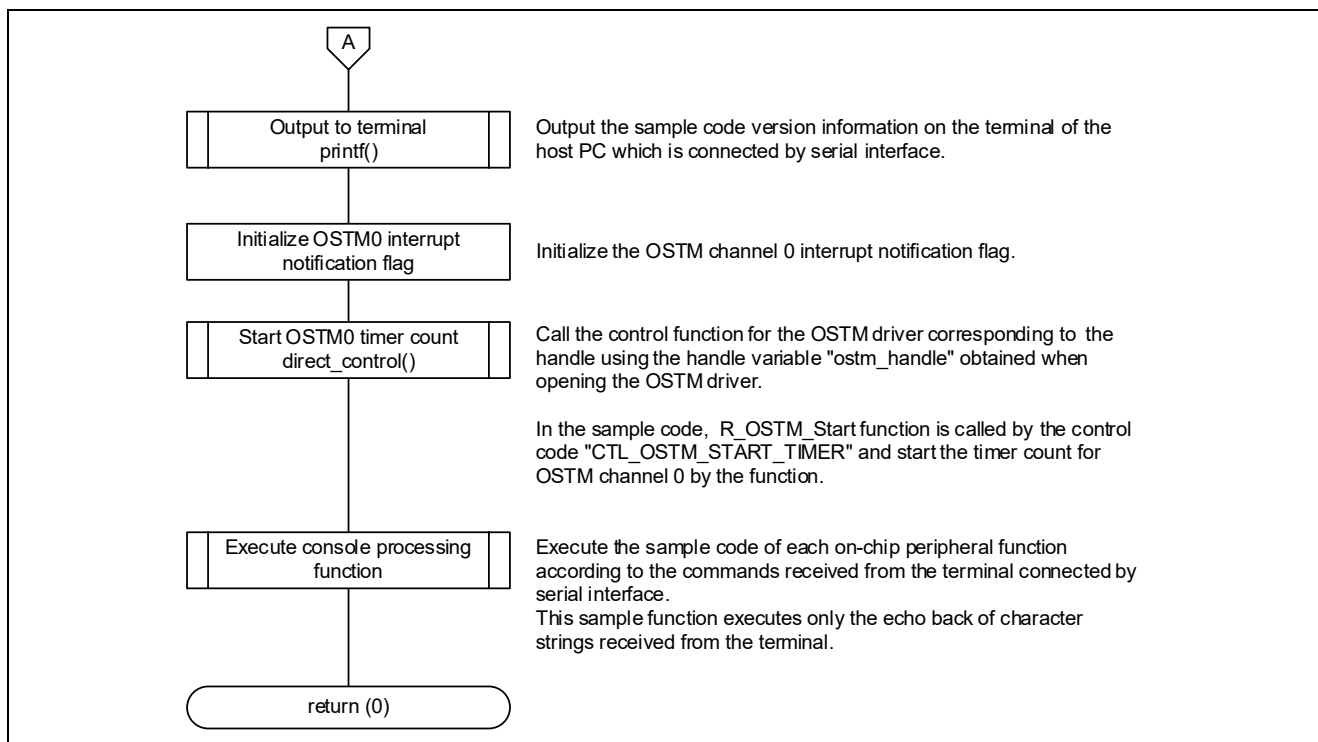
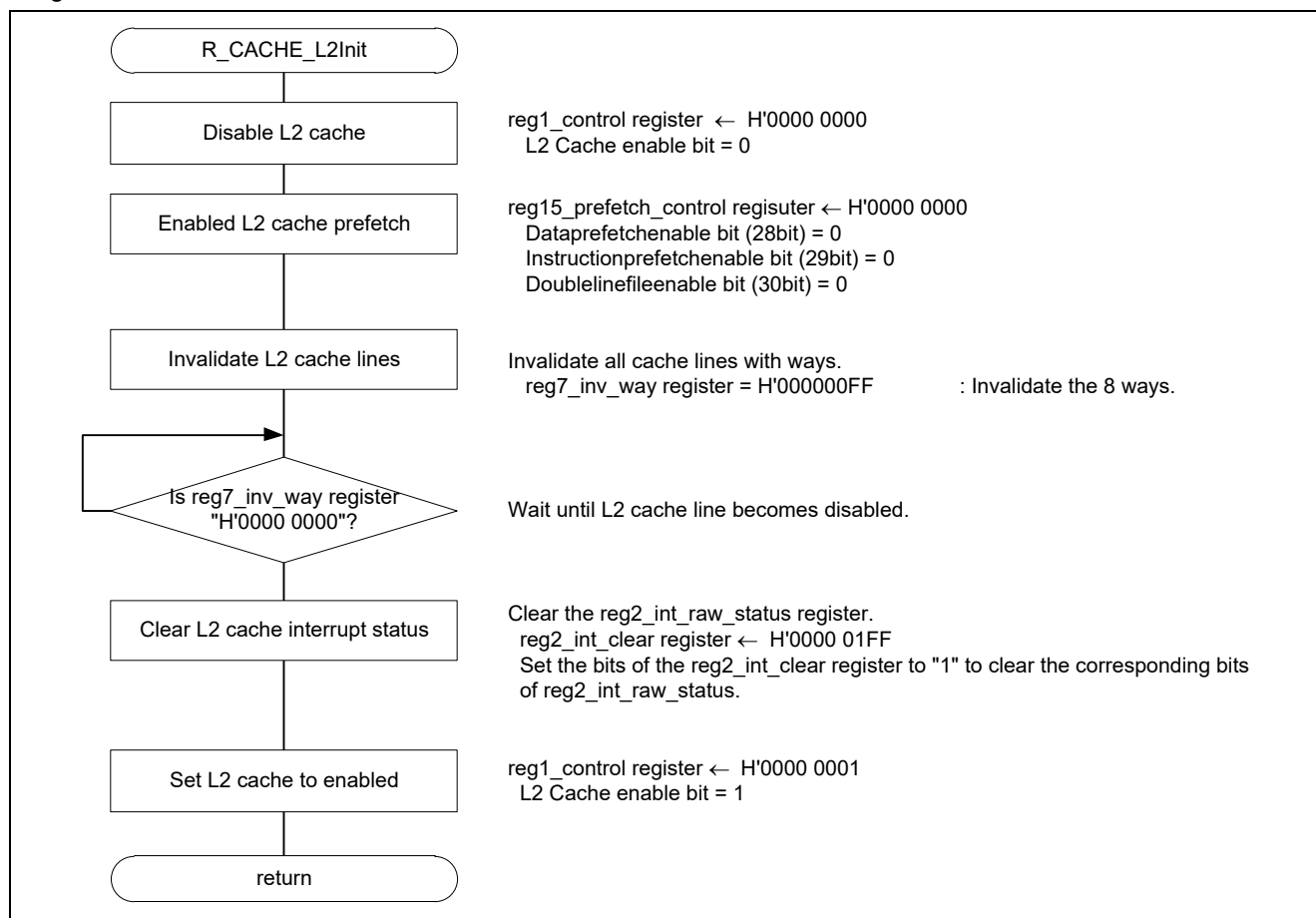


Figure 5.15 Main Processing (1/2)

**Figure 5.16 Main Processing (2/2)**

### 5.8.4 L2 Cache Initialization Function

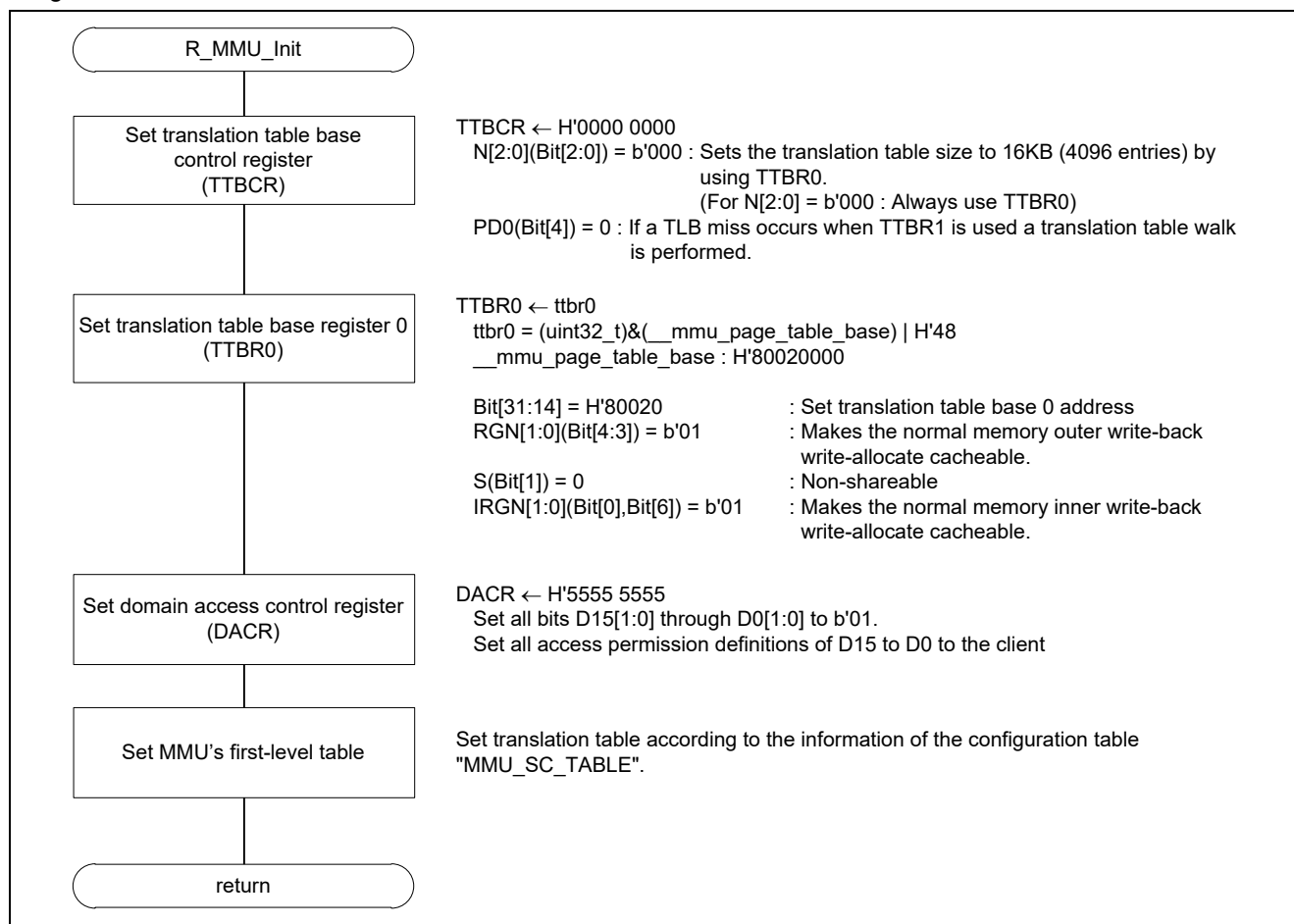
Figure 5.17 shows the flowchart of L2 Cache Initialization Function.



**Figure 5.17 L2 Cache Initialization Function**

### 5.8.5 Initialization Function for MMU

Figure 5.18 shows the flowchart of Initialization Function for MMU.



**Figure 5.18 Initialization Function for MMU**

### 5.8.6 Setting Function for MMU Translation Table

Figure 5.19 shows the flowchart of Setting Function for MMU Translation Table.

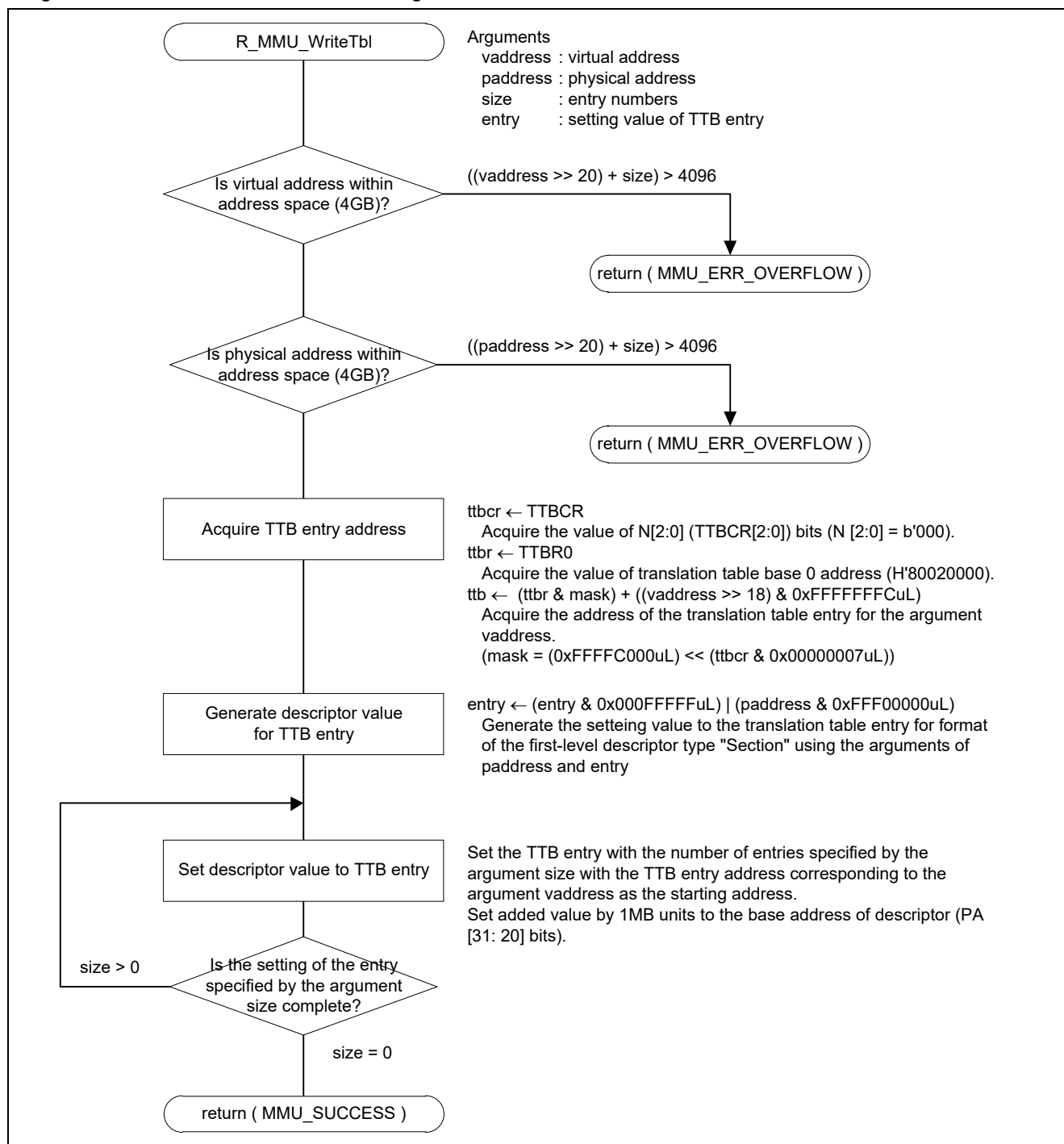
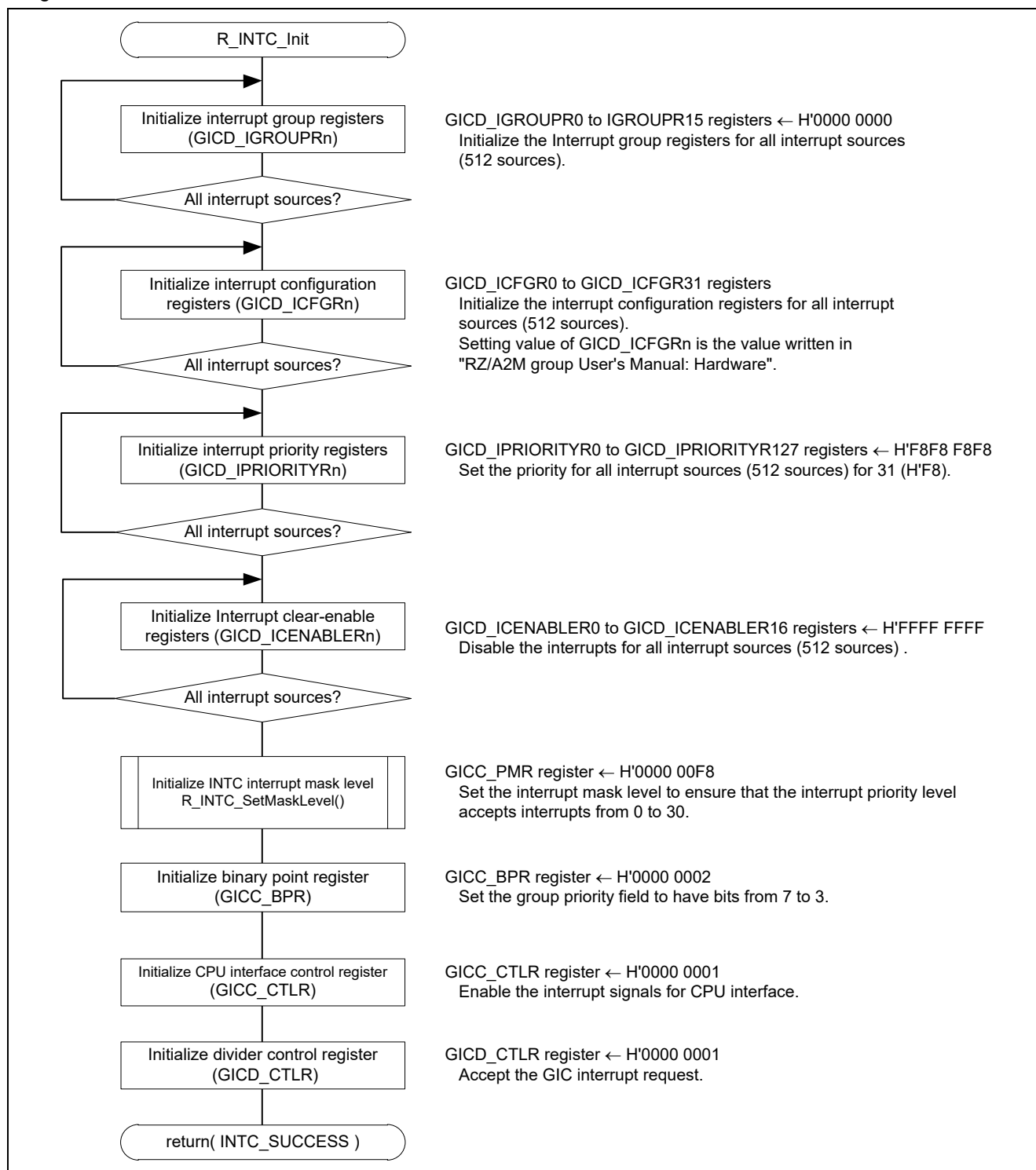


Figure 5.19 Setting Function for MMU Translation Table

### 5.8.7 INTC Initialization Function

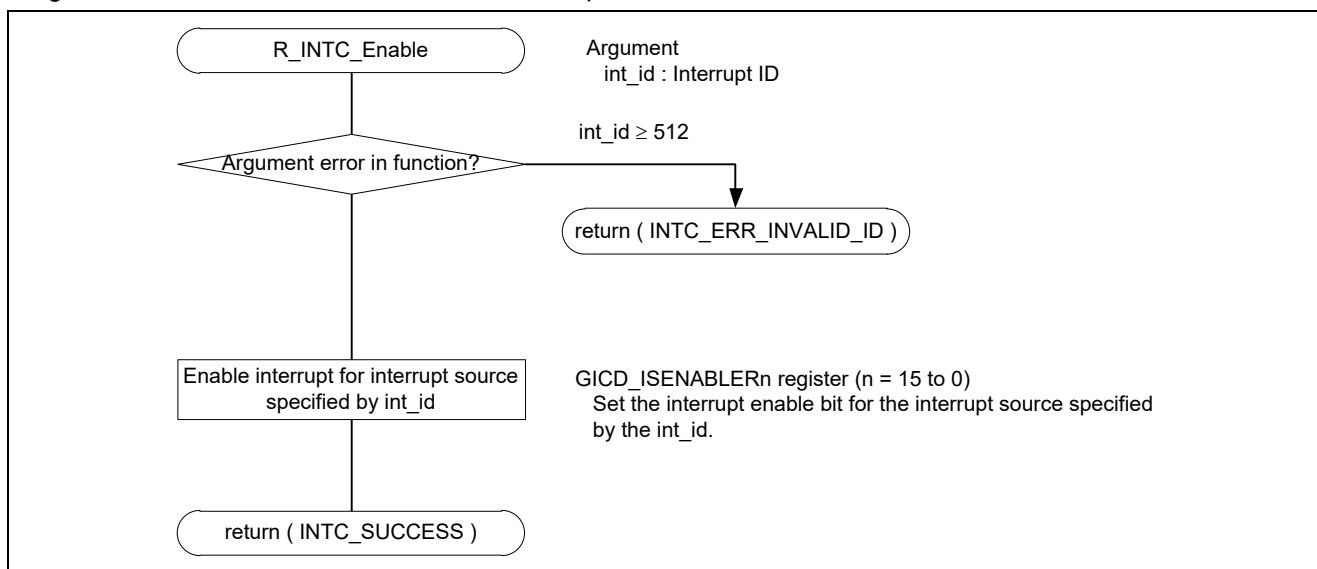
Figure 5.20 shows the flowchart of INTC Initialization Function.



**Figure 5.20 INTC Initialization Function**

### 5.8.8 INTC Interrupt Enable Function

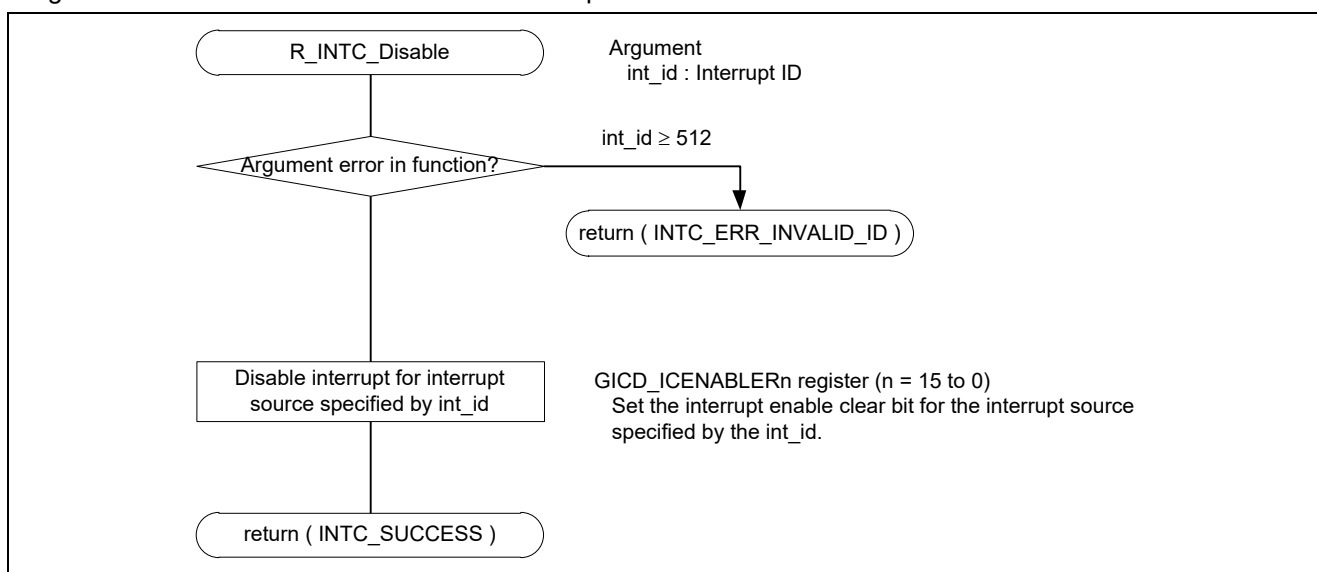
Figure 5.21 shows the flowchart of INTC Interrupt Enable Function.



**Figure 5.21 INTC Interrupt Enable Function**

### 5.8.9 INTC Interrupt Disable Function

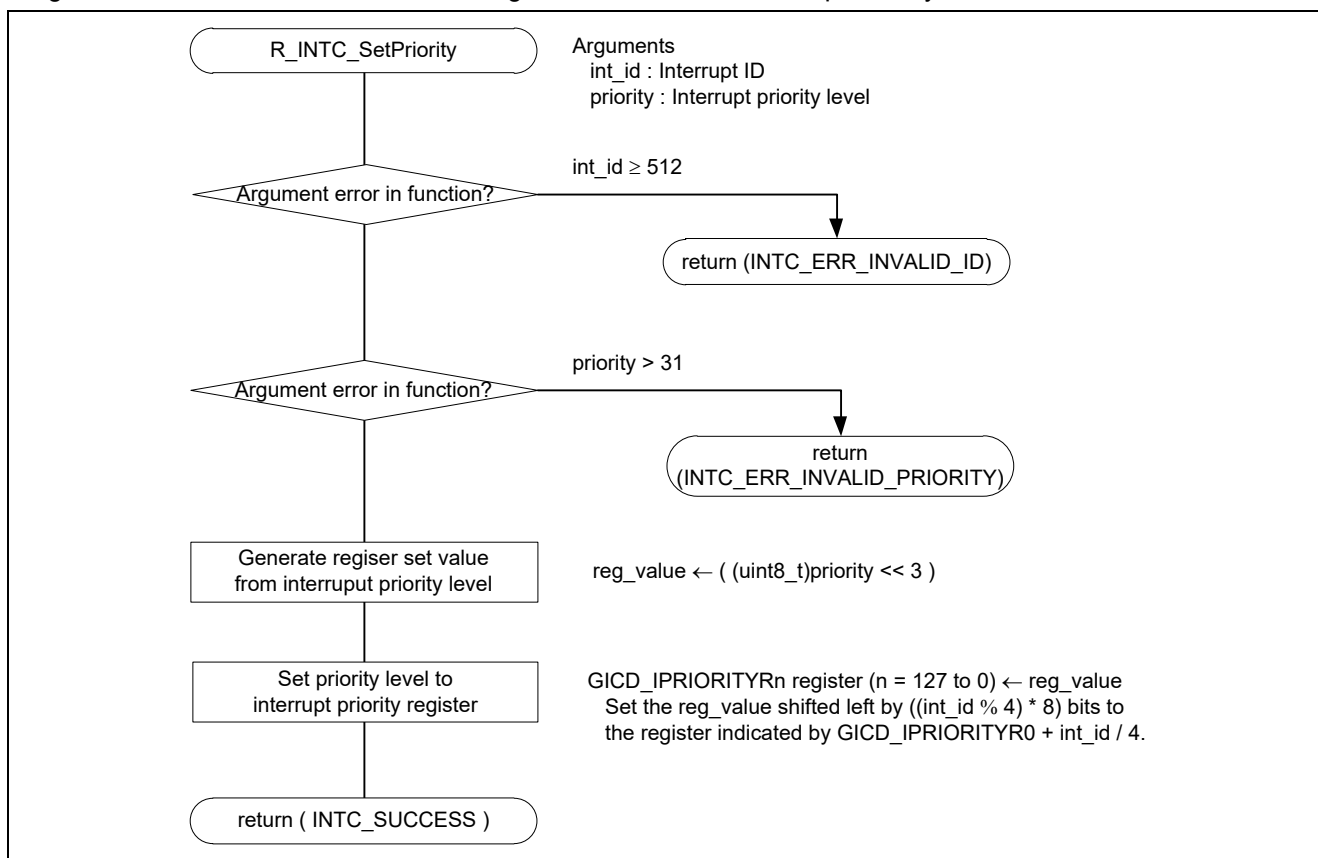
Figure 5.22 shows the flowchart of INTC Interrupt Disable Function.



**Figure 5.22 INTC Interrupt Disable Function**

### 5.8.10 Setting Function for INTC Interrupt Priority Level

Figure 5.23 shows the flowchart of Setting Function for INTC Interrupt Priority Level.

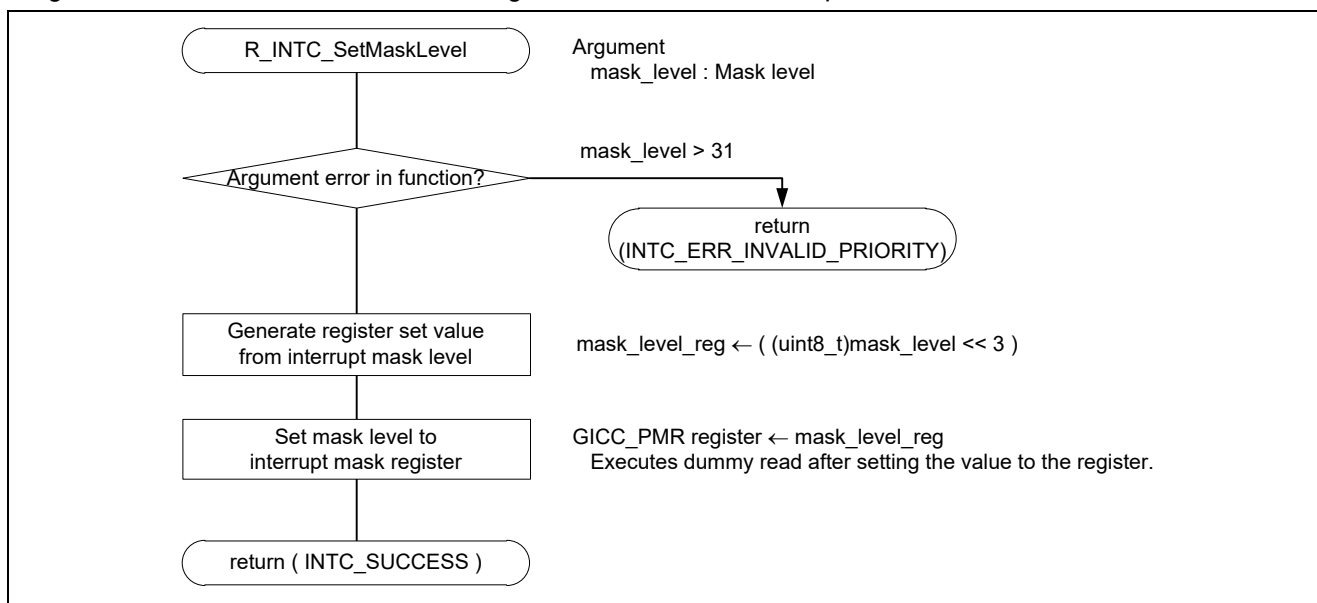


**Figure 5.23 Setting Function for INTC Interrupt Priority Level**



### 5.8.11 Setting Function for INTC Interrupt Mask Level

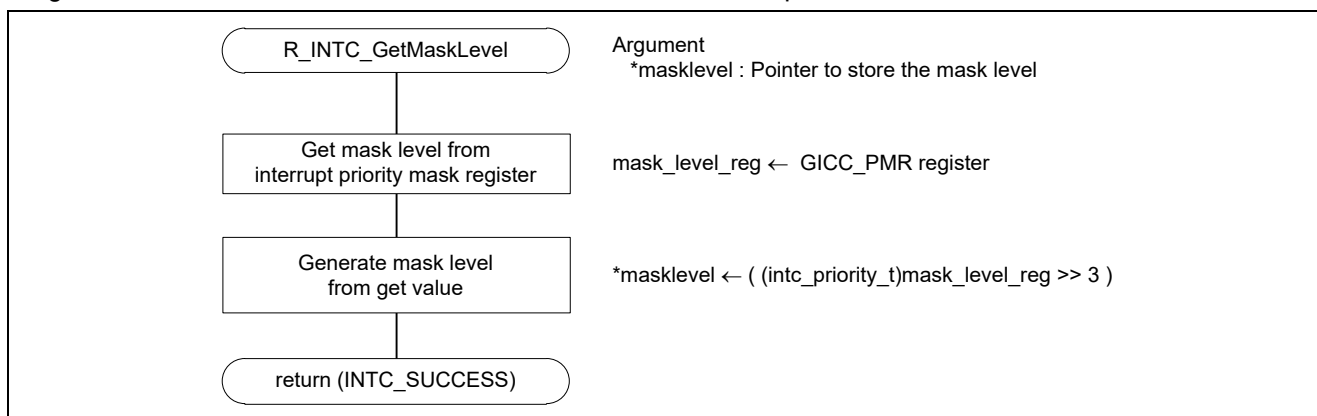
Figure 5.24 shows the flowchart of Setting Function for INTC Interrupt Mask Level.



**Figure 5.24 Setting Function for INTC Interrupt Mask Level**

### 5.8.12 Get Function for INTC Interrupt Mask Level

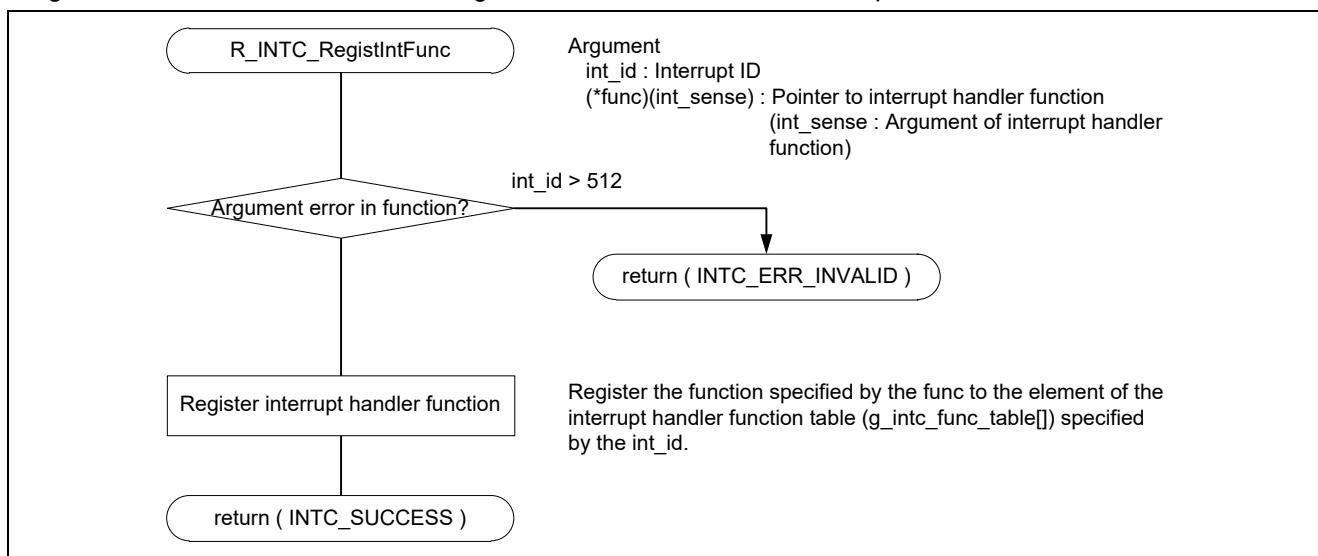
Figure 5.25 shows the flowchart of Get Function for INTC Interrupt Mask Level.



**Figure 5.25 Get Function for INTC Interrupt Mask Level**

### 5.8.13 Registration Function of INTC Interrupt Handler Function

Figure 5.26 shows the flowchart of Registration Function of INTC Interrupt Handler Function.



**Figure 5.26 Registration Function of INTC Interrupt Handler Function**

### 5.8.14 IRQ Handler Processing

Figure 5.27 shows the flowchart of IRQ Handler Processing.

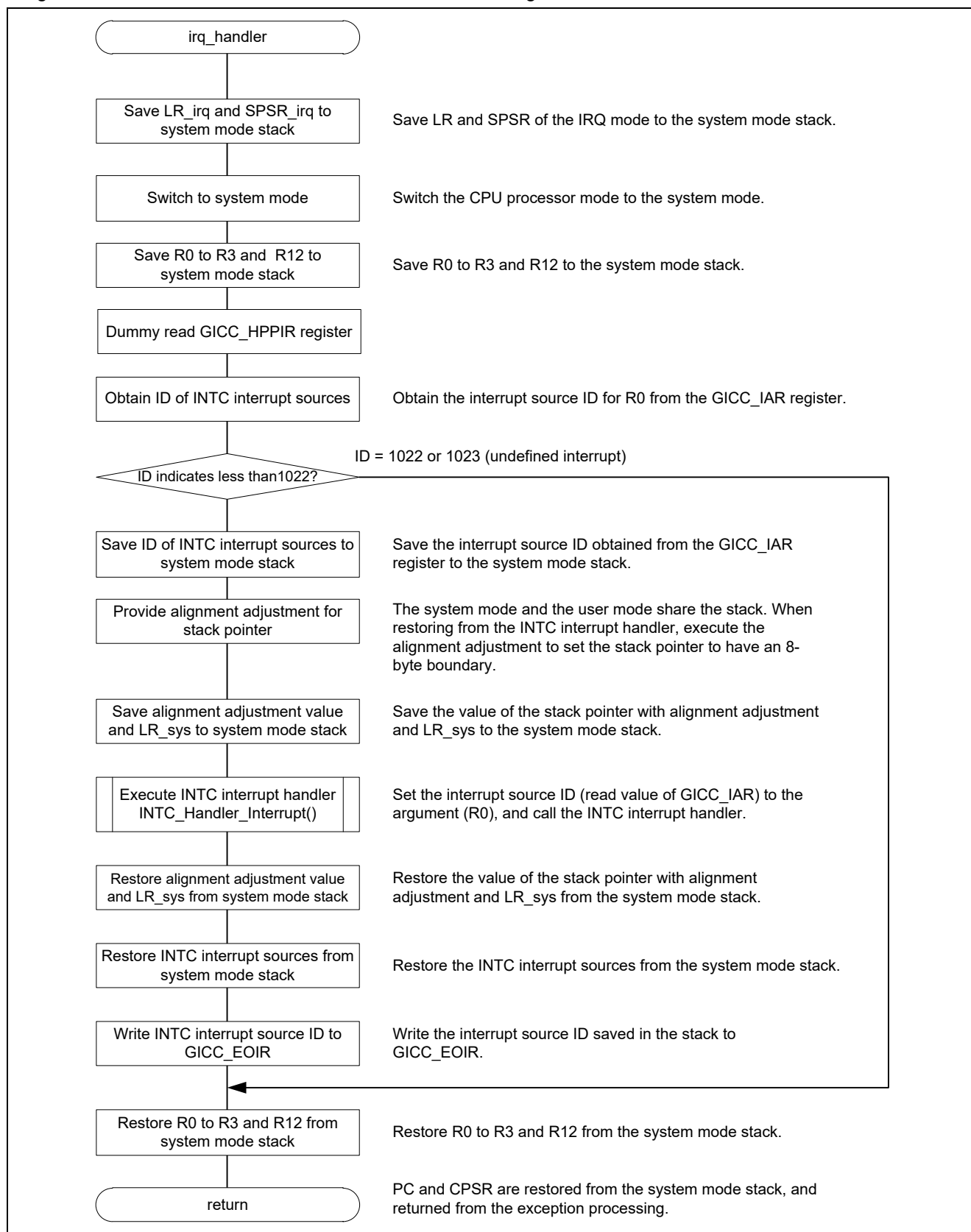


Figure 5.27 IRQ Handler Processing

### 5.8.15 INTC Interrupt Handler Processing

Figure 5.28 shows the flowchart of INTC Interrupt Handler Processing.

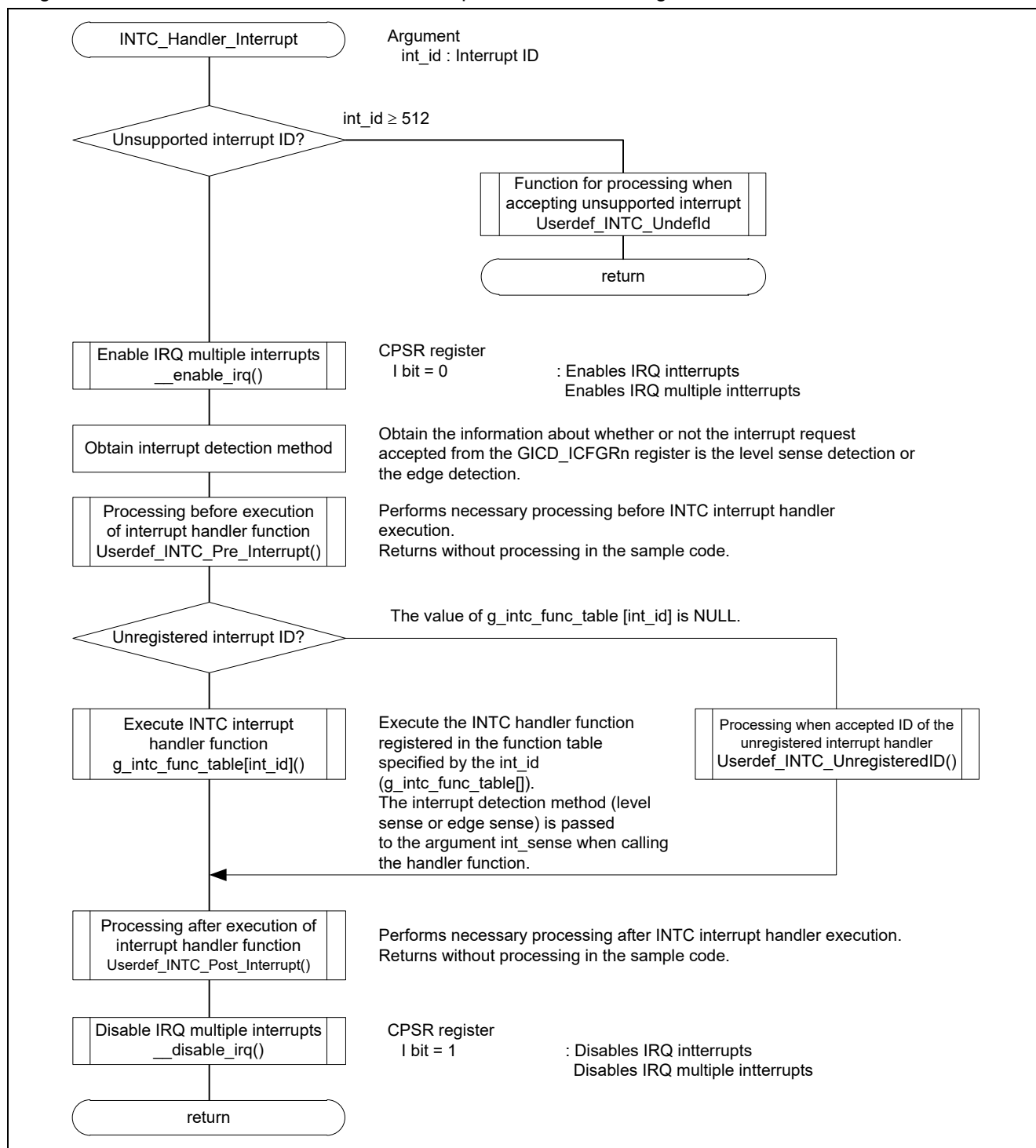


Figure 5.28 INTC Interrupt Handler Processing

## 6. Sample Code

Sample code can be downloaded from the Renesas Electronics website.

## 7. Reference Documents

### User's Manual: Hardware

RZ/A2M Group User's Manual: Hardware

The latest version can be downloaded from the Renesas Electronics website.

RTK7921053C00000BE (RZ/A2M CPU board) User's Manual

The latest version can be downloaded from the Renesas Electronics website.

RTK79210XXB00000BE (RZ/A2M SUB board) User's Manual

The latest version can be downloaded from the Renesas Electronics website.

ARM Architecture Reference Manual ARMv7-A and ARMv7-R edition Issue C

The latest version can be downloaded from the ARM website.

ARM Cortex™-A9 Technical Reference Manual Revision: r4p1

The latest version can be downloaded from the ARM website.

ARM Generic Interrupt Controller Architecture Specification - Architecture version 2.0

The latest version can be downloaded from the ARM website.

ARM CoreLink™ Level 2 Cache Controller L2C-310 Technical Reference Manual Revision: r3p3

The latest version can be downloaded from the ARM website.

### Technical Update/Technical News

The latest information can be downloaded from the Renesas Electronics website.

### User's Manual: Development Tools

Integrated development environment e2studio User's Manual can be downloaded from the Renesas Electronics website.

The latest version can be downloaded from the Renesas Electronics website.

## Revision History

Rev.	Date	Description	
		Page	Summary
Rev.1.00	Oct.04.18	—	First edition issued
Rev.1.10	Dec.28.18	P4	Table 1.1 Peripheral Function to be Used Added OSTM2.
		P12	Table 5.1 Setting for Peripheral Functions Added OSTM2.
		P18	Table 5.6 MMU settings (2/2) Changed "CS3 space non-cacheable area", "HyperRAM non-cacheable area", "OctaRAM non-cacheable area" setting.
		P22	Table 5.7 Memory Area to be used <ul style="list-style-type: none"> <li>Moved section for IO register access.</li> <li>Added UNCACHED_DATA section.</li> </ul>
		P23	Figure 5.6 Section Assignment <ul style="list-style-type: none"> <li>Moved section for IO register access.</li> <li>Added UNCACHED_DATA section.</li> </ul>
		P31	Table 5.9 Interrupts Used in Sample Program Added OSTM2 interrupt.
		P32	Added Table 5.12 Constants Used by GPIO Driver (1)
		P32	Added Table 5.13 Constants Used by GPIO Driver (2)
		P32	Added Table 5.14 Constants Used by GPIO Driver (3)
		P34	Table 5.16 API Functions (1/2) Added R_MMU_ReadTbl(), R_MMU_VAtoPA().
		P43 to 44	5.7 Function Specification Added R_MMU_ReadTbl(), R_MMU_VAtoPA().
		P53 to 54	5.7 Function Specification Add notes to R_GPIO_HWInitialise(), R_GPIO_InitByPinList(), and, R_GPIO_InitByTable().
		P63	Figure 5.13 Reset Handler Processing Added write access permission processing to Retention RAM (pages 3 to 0).
Rev.1.20	Apr.15.19	—	Modified the sample code to be able to output CKIO
		P25	5.2.6 L1 and L2 Cache Settings Added notes on enabling cache.
		P63	Figure 5.13 Reset Handler Processing <ul style="list-style-type: none"> <li>Changed the setting procedure of NEON and VFP in initial setting process.</li> <li>Added processing to clear IOKEEP bit of DSFR register.</li> </ul>
		P64	Figure 5.14 resetprg Function Added notes on enabling cache.
		P65	Figure 5.15 Main Processing (1/2) Changed the description when opening the CPG driver.

Rev.	Date	Description	
		Page	Summary
Rev.1.30	May.17.19	P6	Table 2.2 Operation Conformation Condition (2/2) Remove compiler option "-mthumb-interwork"
Rev.1.40	Nov.20.19	P22 P23	Changed the following table and figure because an input section for processing of the R_SC_HardwareSetup function was added. <ul style="list-style-type: none"> <li>Table 5.7 Memory Area to be used</li> <li>Figure 5.6 Section Assignment</li> </ul>
		P35 P62	Added to functions and function specification because of addition the Userdef_PreHardwareSetup function and the Userdef_PostHardwareSetup function <ul style="list-style-type: none"> <li>Table 5.18 User Defined Functions</li> <li>Funtion Specification</li> </ul>
		P63	Figure 5.13 Reset Handler Processing Fixed the figure due to a clerical error of the processing order about "Initialize floating-point functions" and "Initialize sections".
		P65	Figure 5.15 Main Processing (1/2) Fixed a crelical error of function name (corrected from initialise_monitor_handles function to R_OS_AbstractionLayerInit function).

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

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## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

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